

DESIGNING TWISTED GRAPHENE BASED DEVICES

JOVI K

P0181214

SEM 9 THESIS

PROJECT GUIDE:

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Karlsruher Institut für Technologie



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ACKNOWLEDGEMENT



Image Location: INT-KIT, Karlsruhe

I give my deepest thanks to my supervisor
Dr. Romain Danneau,
and Prof. Ralph Krupke,
Group Head and my gratitude for all
members of Krupke Group and INT.



Karlsruher Institut für Technologie

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INTRODUCTION



Previous Stacking
Procedure



Modified
Procedure



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Image credit: GenerativeAI

SESSION 1

INTRODUCTION



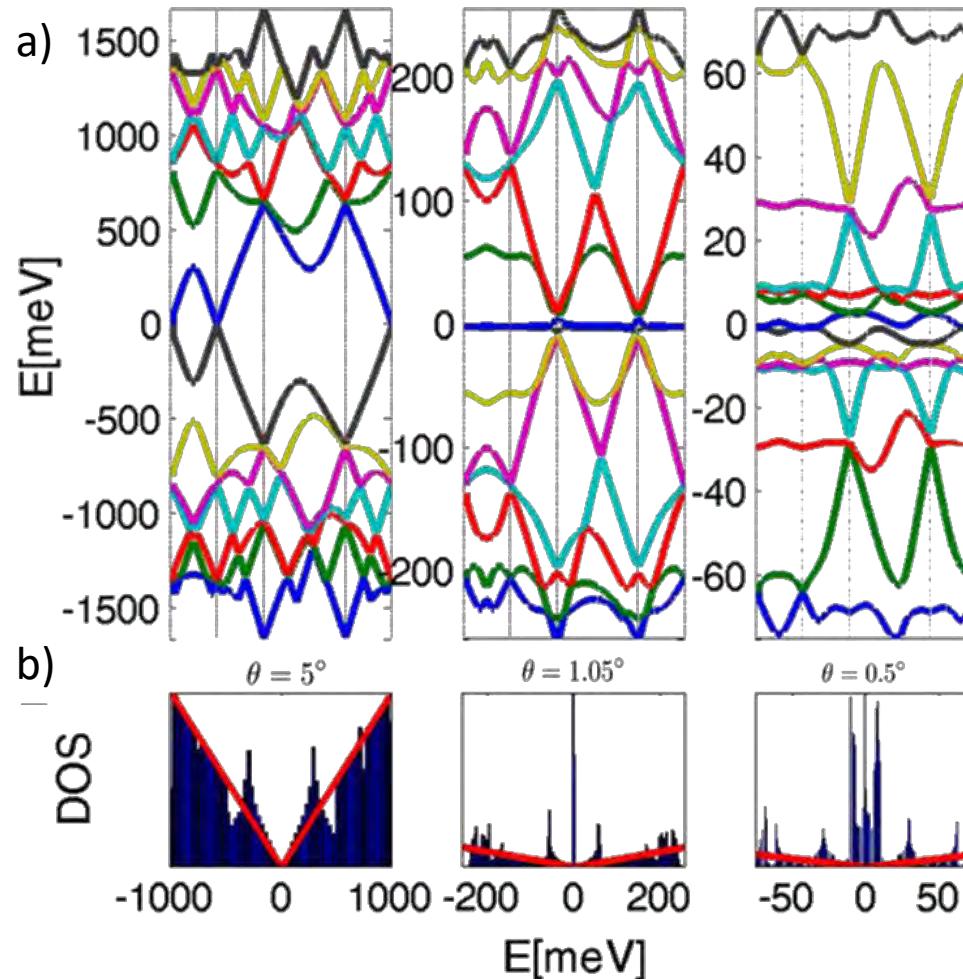
Image credit: [here](#)

PREDICTION OF MAGIC ANGLE tBLG:



CONCLUSION

Emergence of strongly correlated system in Bi-Layer Graphene for twist $\sim 1.1^\circ, 0.5^\circ, \dots$



Bistritzer, R. & MacDonald, A. H. Moiré bands in twisted double-layer graphene. Proceedings of the National Academy of Sciences 108, 12233–12237 (2011).



GRAPH

Fig 2: Moiré bands: (a) Energy dispersion for the 14 bands closest to the Dirac point plotted along the k-space trajectory. (b) DOS.

TEAR AND STACK PROCEDURE FOR BLG:

IMAGE

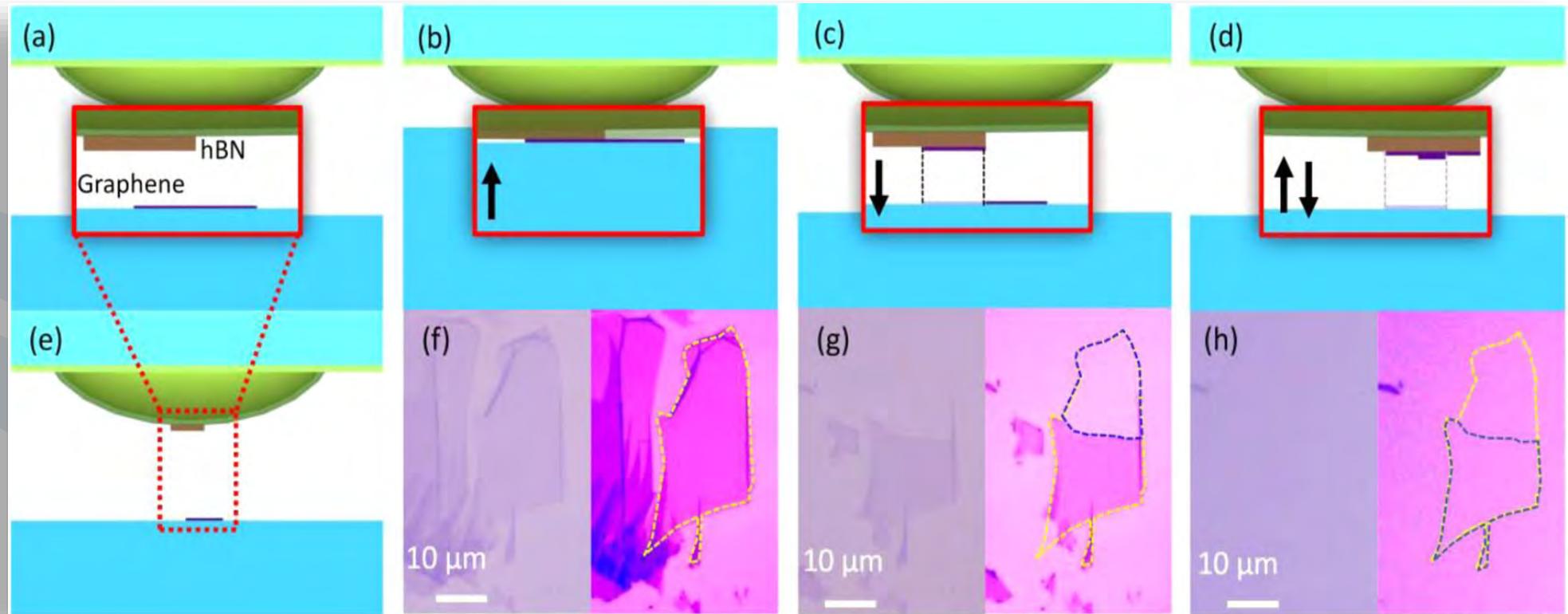


Fig 4: Rotationally aligned graphene double layer realized by successive transfers from a monolayer graphene using a hemispherical handle substrate.



CAPTION

Kim, K. et al. Van der Waals Heterostructures with High Accuracy Rotational Alignment. *Nano Letters* 16, 1989–1995 (2016).

Cao, Y. et al. Superlattice-Induced Insulating States and Valley-Protected Orbitals in Twisted Bilayer Graphene. *Physical Review Letters* 117, 116804 (2016).

CONFIRMATION OF MAtBLG:

IMAGE

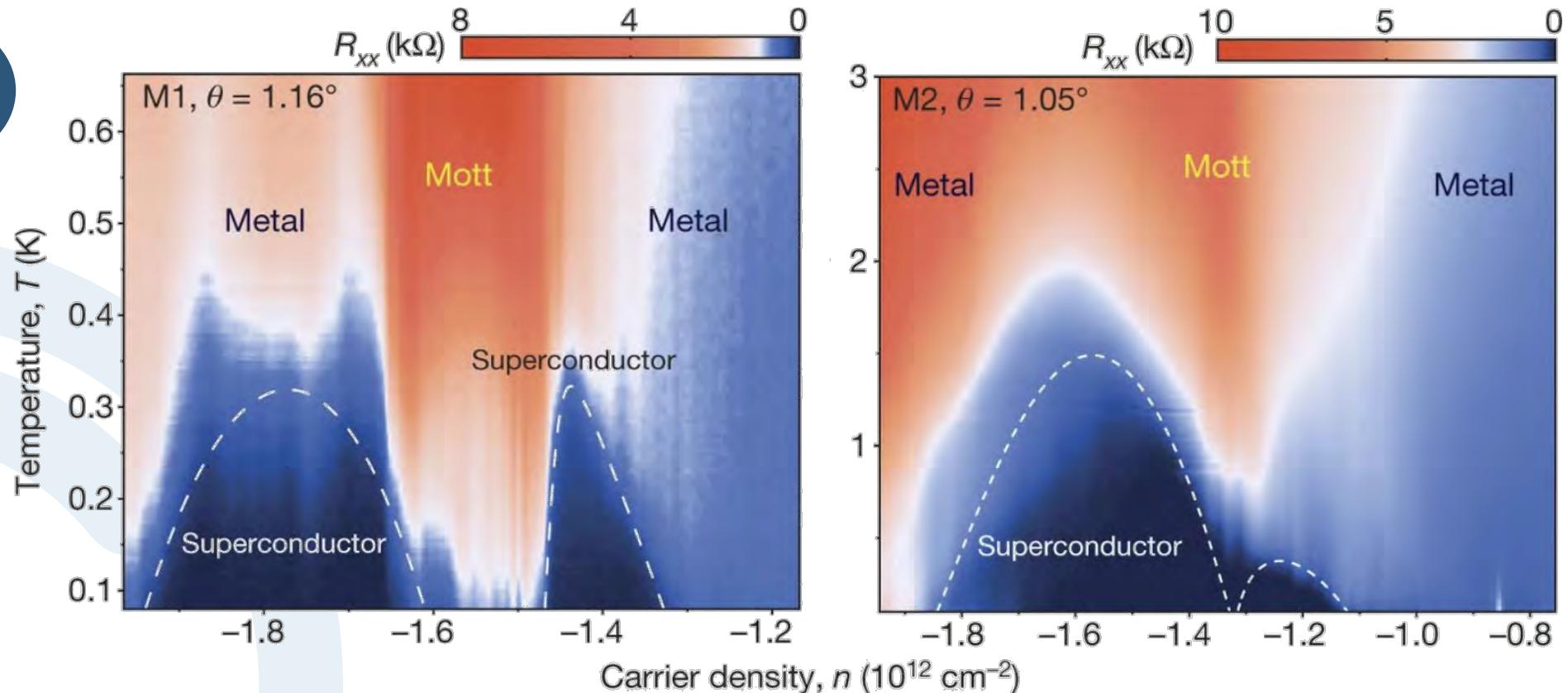


Fig 5: Unconventional Superconductivity in MAtBLG



CAPTION

Cao, Y. et al. Unconventional superconductivity in magic-angle graphene superlattices. Nature 556, 43–50 (2018).

THESIS OBJECTIVE

Standardising the **TEAR**, **TWIST** and **STACKING** in tBLG

- Exploring Efficient ways of tearing a graphene
- Standardising the procedure
- Conclude with fabricating MAtBLG

STACKING PROCEDURE
FOR tBLG

SESSION 2

Reviewing Previous Stacking Procedure

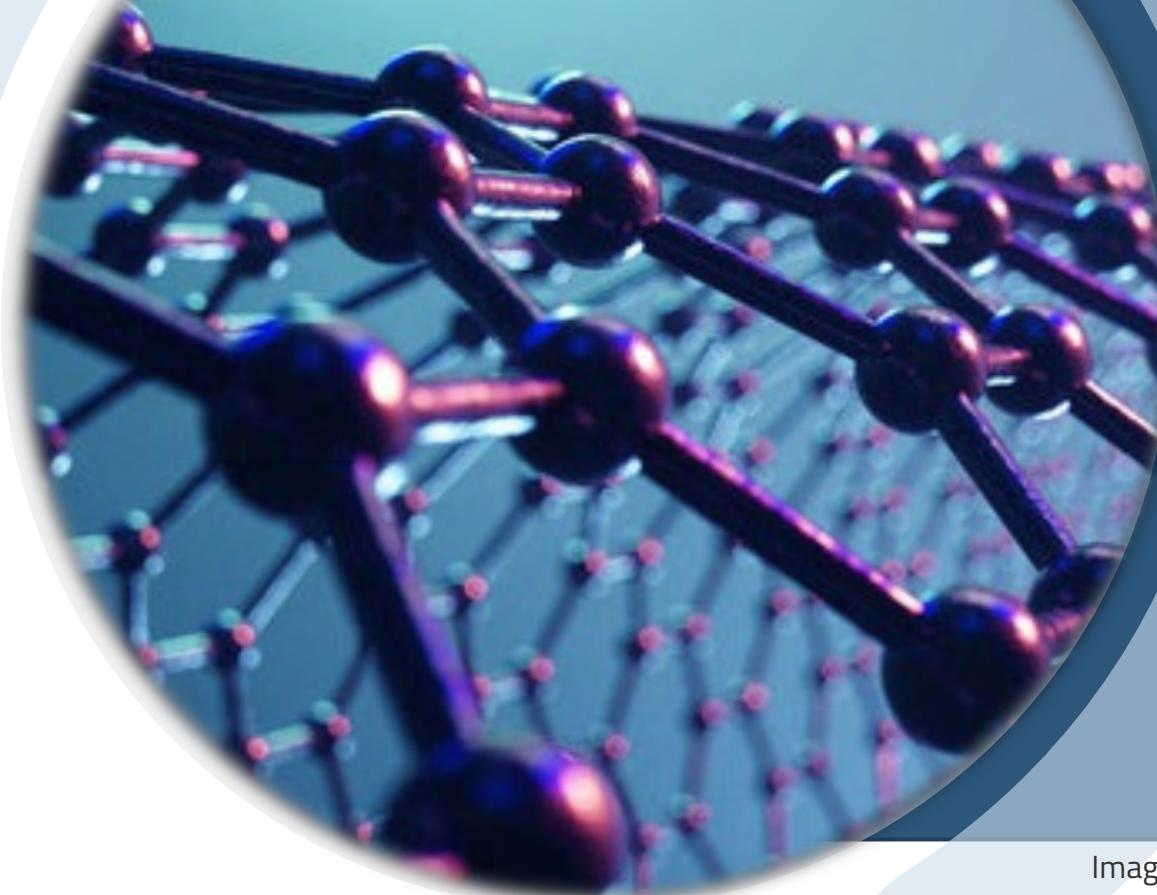


Image credit: [Shutterstock](#)

DRY PROCEDURE :

IMAGE

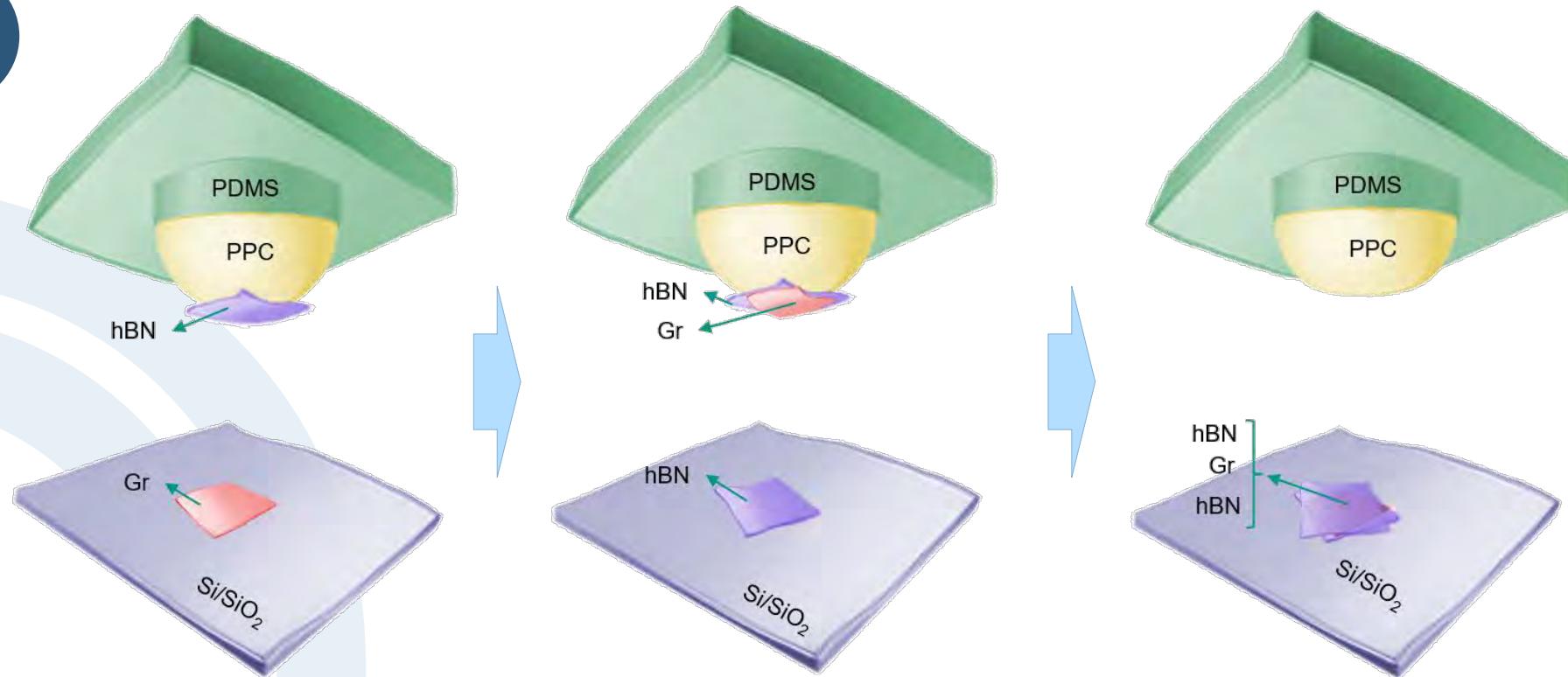


Fig 6: Illustration of van der Waals heterostructure assembly process as done in Danneau Group.



CAPTION

Cao, Y. et al. Unconventional superconductivity in magic-angle graphene superlattices. Nature 556, 43–50 (2018).

DRAWBACKS FOR TBLG:

TEARING PROBLEM



Tear a graphene along the edge
of hBN flake



Avoid PPC stamp contamination
on other half of graphene



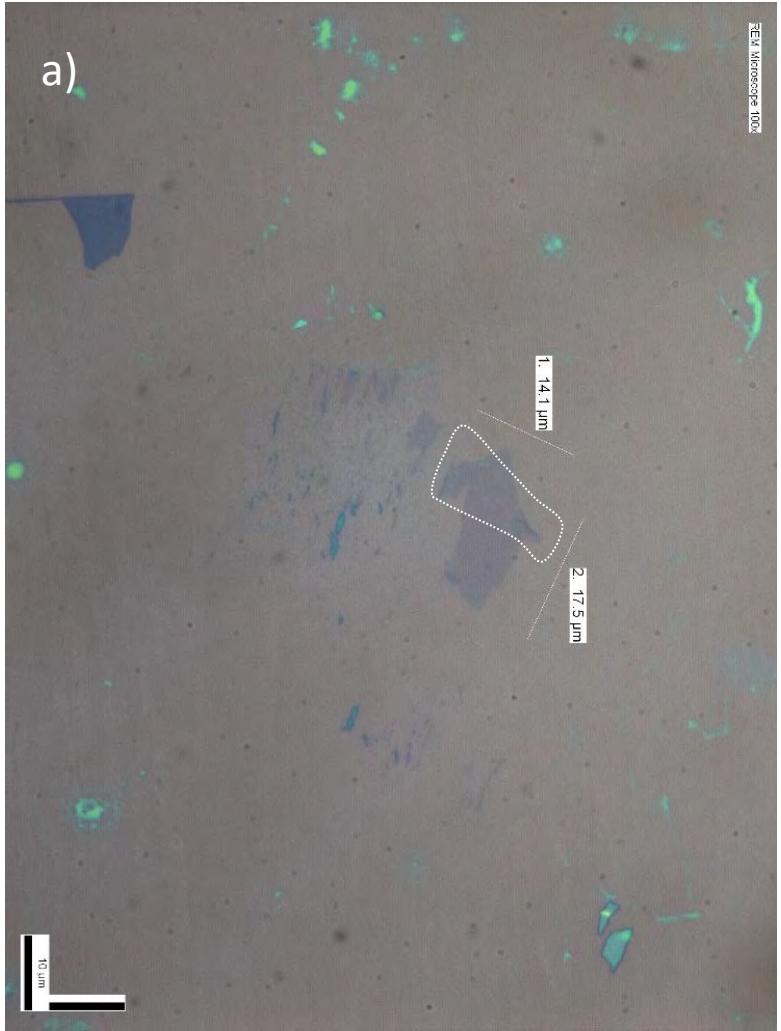
CLEAN INTERFACE PROBLEM

SESSION 3

Modified Dry Stacking Procedure



TEAR PROBLEM



INFLUENCE

- Fig 6: tab A graph with flake before Graphite. b) Same flake after pickup. Faint outline is only the contact region of hBN
- previous cracks

TEARING A PAPER:

TEAR ALONG AN EDGE



RIPPING APART

TEARING A PAPER - RIPPING APART:

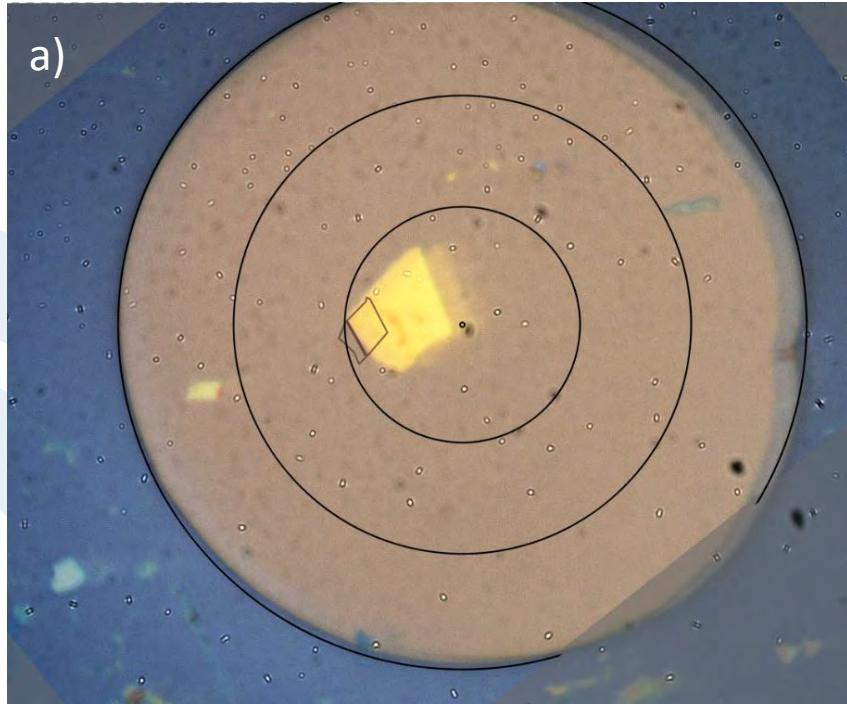
The Tensile Strength of Paper



D. L. Mathieson, *The Tensile Strength of Paper*, Phys Teach 29, 412 (1998).

TEAR ALONG AN EDGE - DRY STACK PROCEDURE :

IMAGE



a)

b)

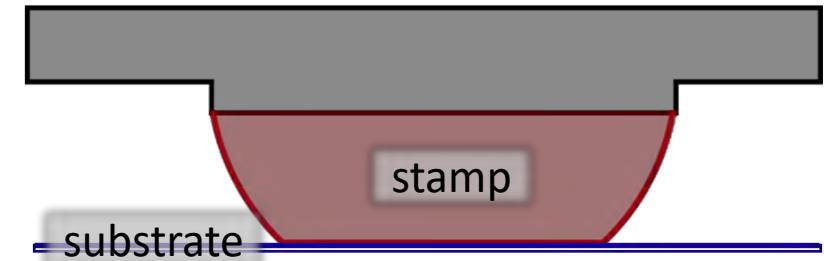


Fig 9: (a) Optical image during stacking. Concentric circles and tear outlines are overlaid and (b) cross sectional schematic.



CAPTION

Cao, Y. et al. Unconventional superconductivity in magic-angle graphene superlattices. Nature 556, 43–50 (2018).

TEARING A PAPER:

TEAR ALONG AN EDGE



USING KNIFE

AFM TEAR - USING KNIFE:

IMAGE

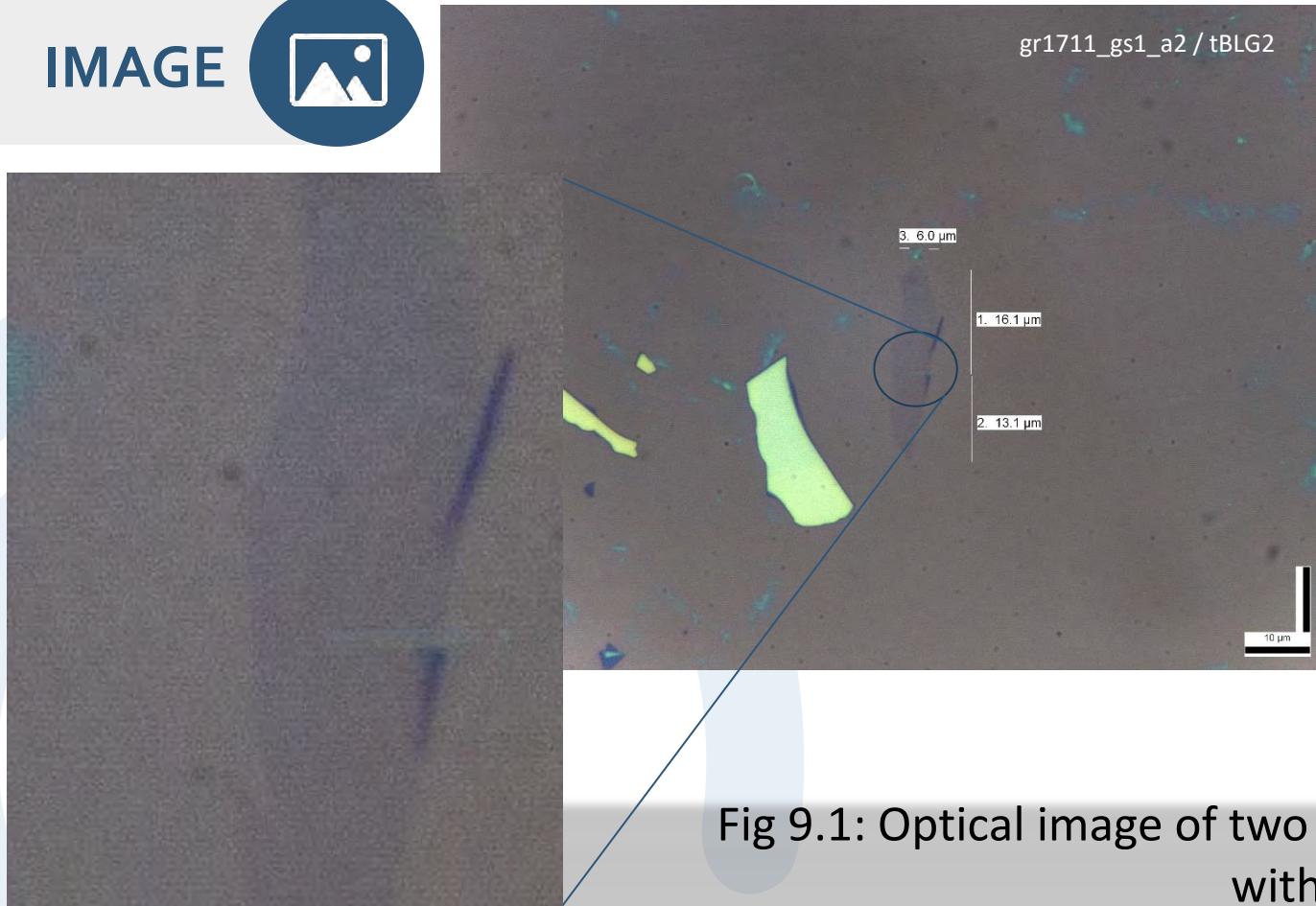
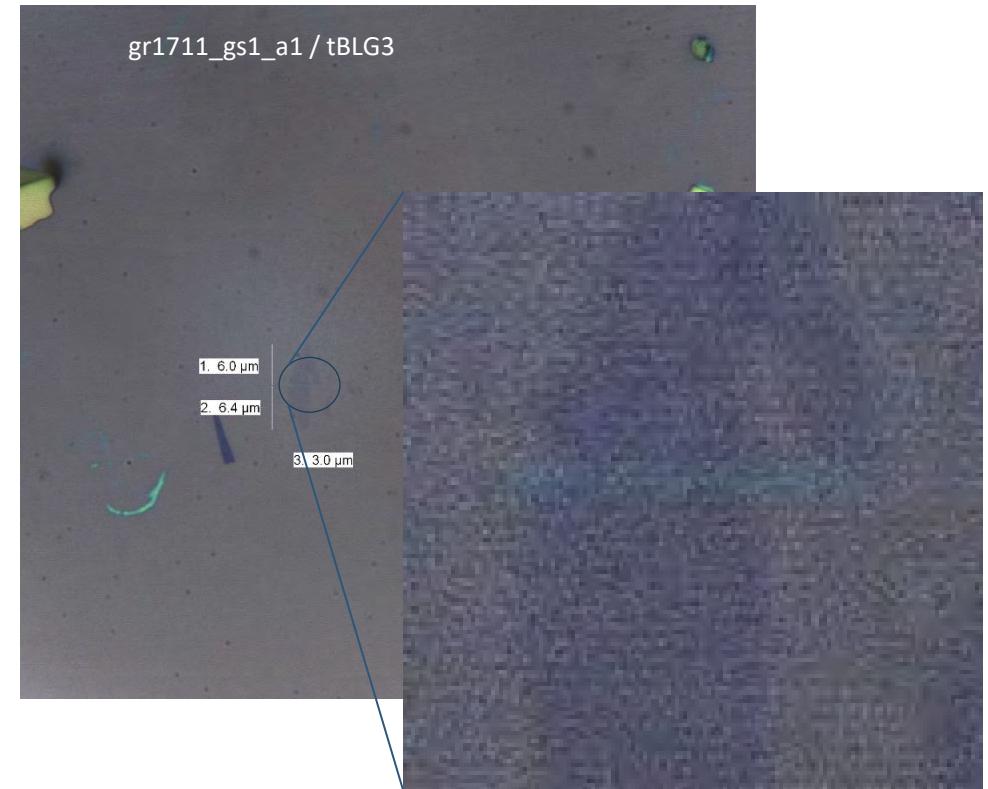


Fig 9.1: Optical image of two graphene flakes with a tear partition

gr1711_gs1_a1 / tBLG3



CAPTION



Cao, Y. et al. Unconventional superconductivity in magic-angle graphene superlattices. Nature 556, 43–50 (2018).

DRAWBACKS FOR TBLG:

TEARING PROBLEM

Tear a graphene along the edge
of hBN flake

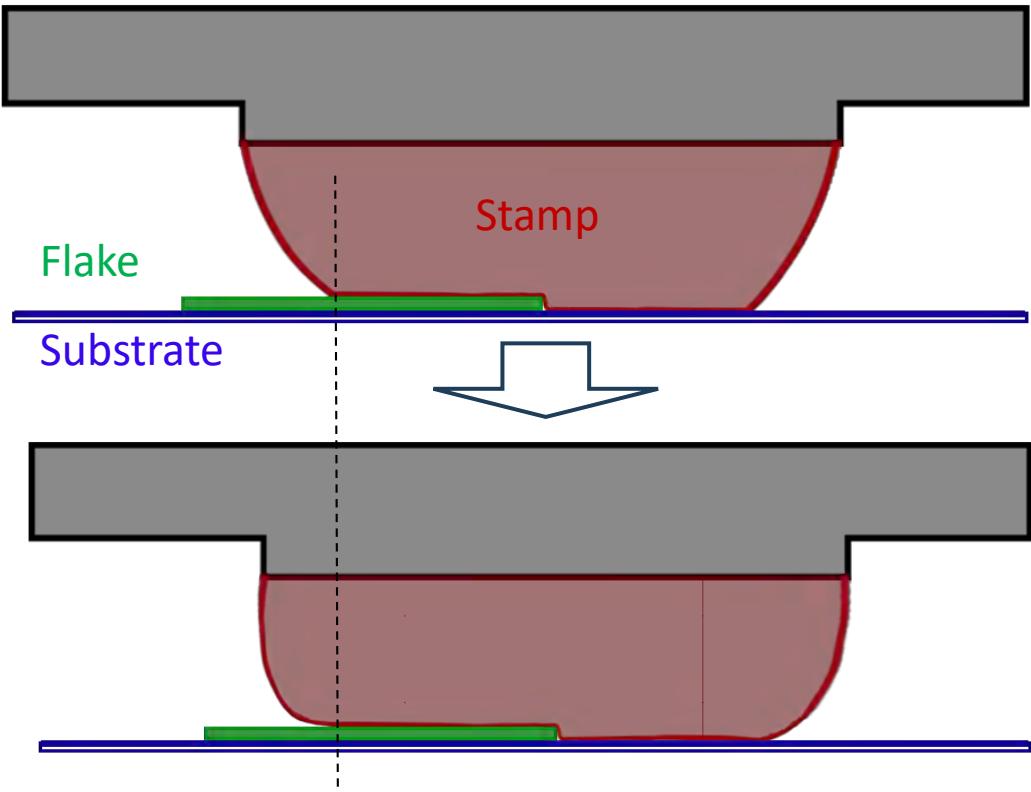


Avoid PPC stamp contamination
on other half of graphene



CLEAN INTERFACE PROBLEM

CLEAN INTERFACE PROBLEM



IMAGE

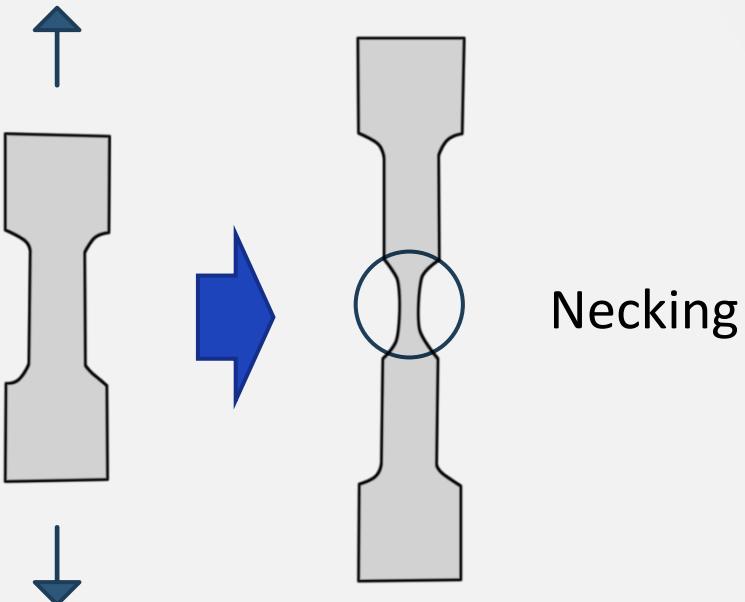
Fig 10: cross sectional schematic of the effect of heat on hemispherical stamp

CLEAN INTERFACE PROBLEM

CONVEX stamp



- ✓ Easy to detach from substrate after contact
- ✗ Contact edge expansion CANNOT be controlled



CONCAVE stamp



- ✗ NECK FORMATION and breakage

- ✓ Contact edge expansion CAN be controlled

Fig 13: Formation and neck and eventual breakage.

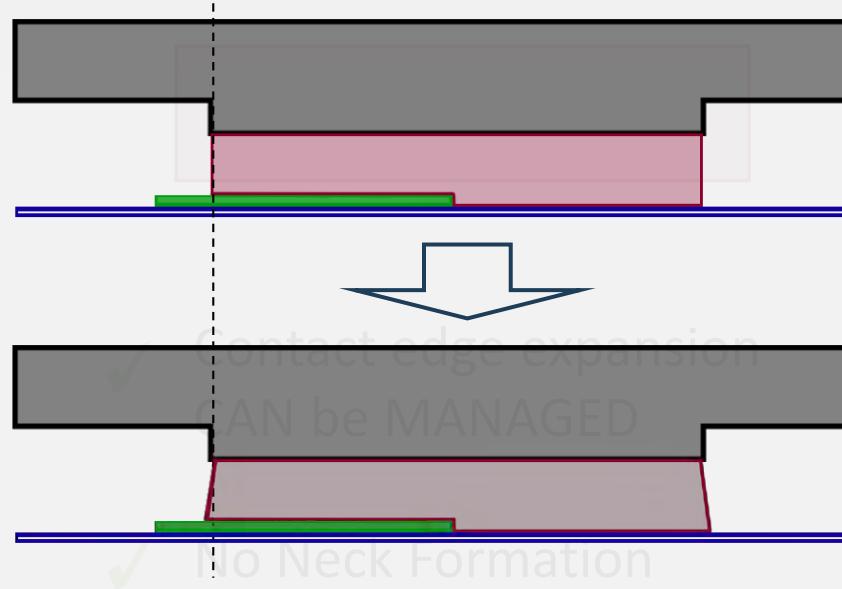
CLEAN INTERFACE PROBLEM

CONVEX stamp



- ✓ Easy to detach from substrate after contact
- ✗ Contact edge expansion CANNOT be controlled

CYLINDRICAL stamp



- ✗ Easy to detach from substrate after contact

CONCAVE stamp



- ✗ NECK FORMATION and breakage

- ✓ Contact edge expansion CAN be controlled

CLEAN INTERFACE PROBLEM

CONVEX stamp



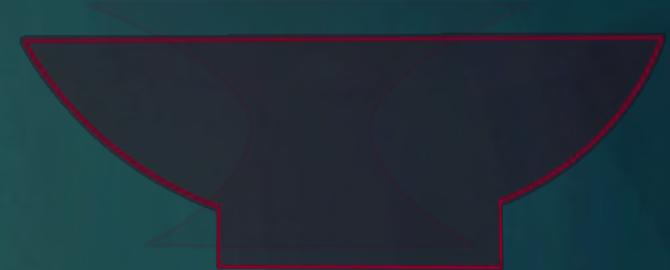
- ✓ Easy to detach from substrate after contact
- ✗ Contact edge expansion CANNOT be controlled

CYLINDRICAL stamp



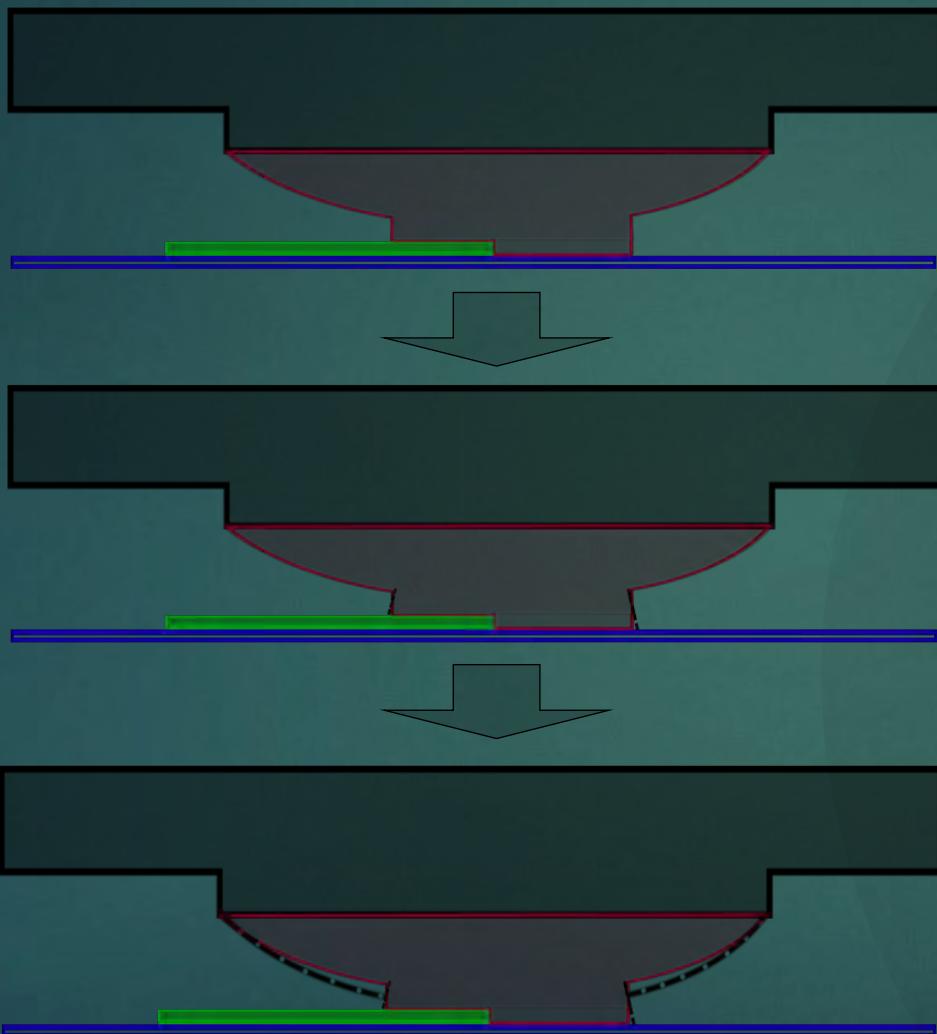
- ✓ Contact edge expansion CAN be MANAGED
- ✓ No Neck Formation
- ✗ Easy to detach from substrate after contact

Convexo-Cylindrical CONCAVE stamp

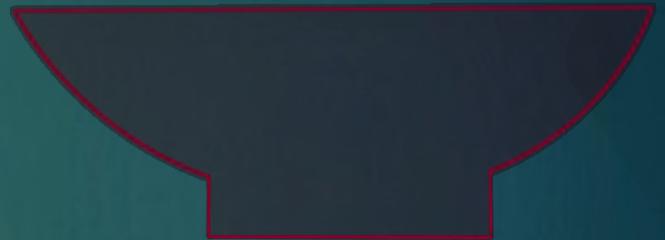


- ✓ Contact edge expansion CAN be MANAGED
- ✓ No Neck Formation
- ✗ Easy to detach from substrate after contact

CLEAN INTERFACE PROBLEM



Convexo-Cylindrical
stamp



- ✓ Contact edge expansion CAN be MANAGED
- ✓ No Neck Formation
- ? Easy to detach from substrate after contact

SESSION 3

CONCLUSION

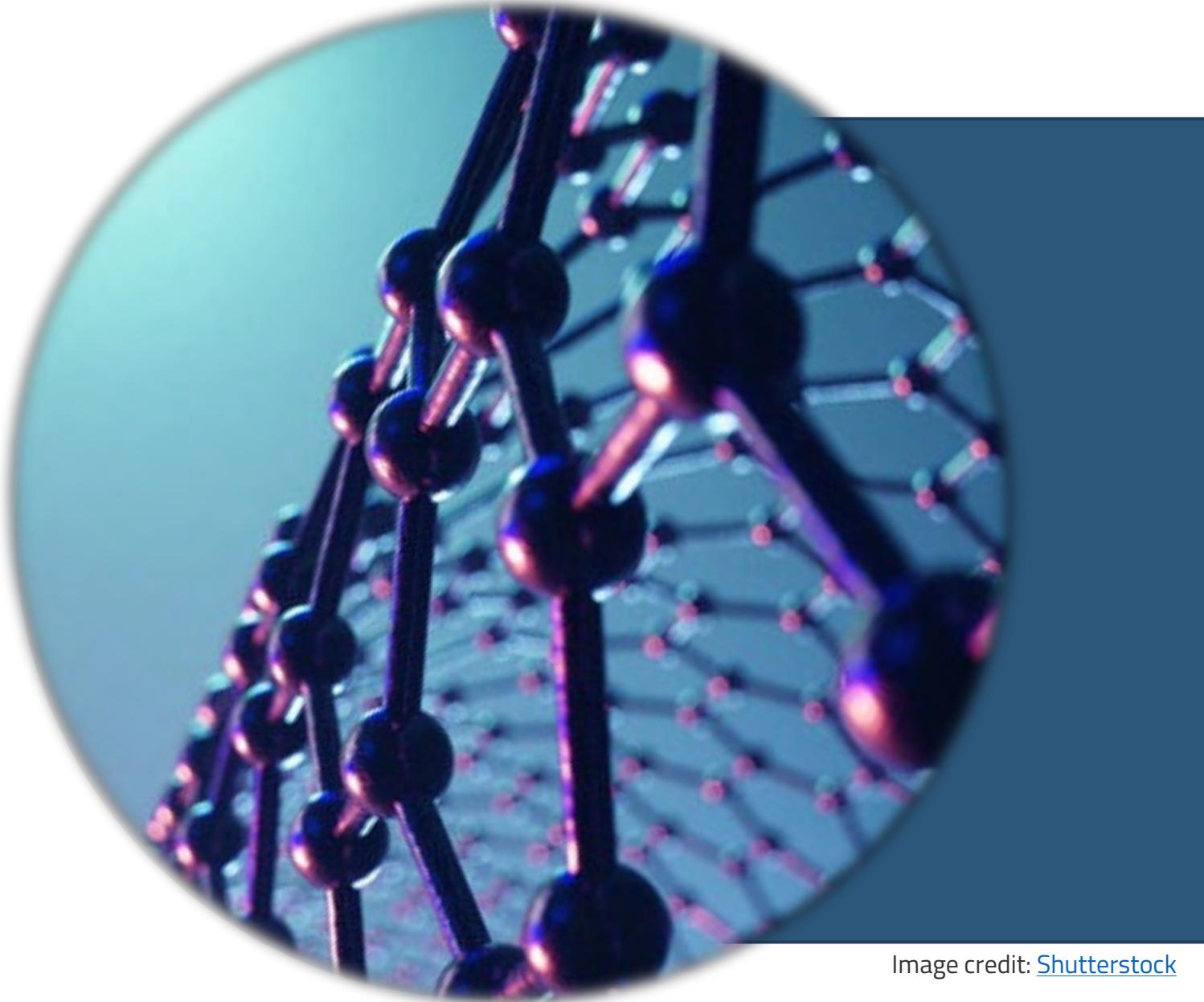


Image credit: [Shutterstock](#)

PROCEDURE FOR TBLG -

1. Exfoliation of hBN and graphene flakes
2. Pickup of hBN

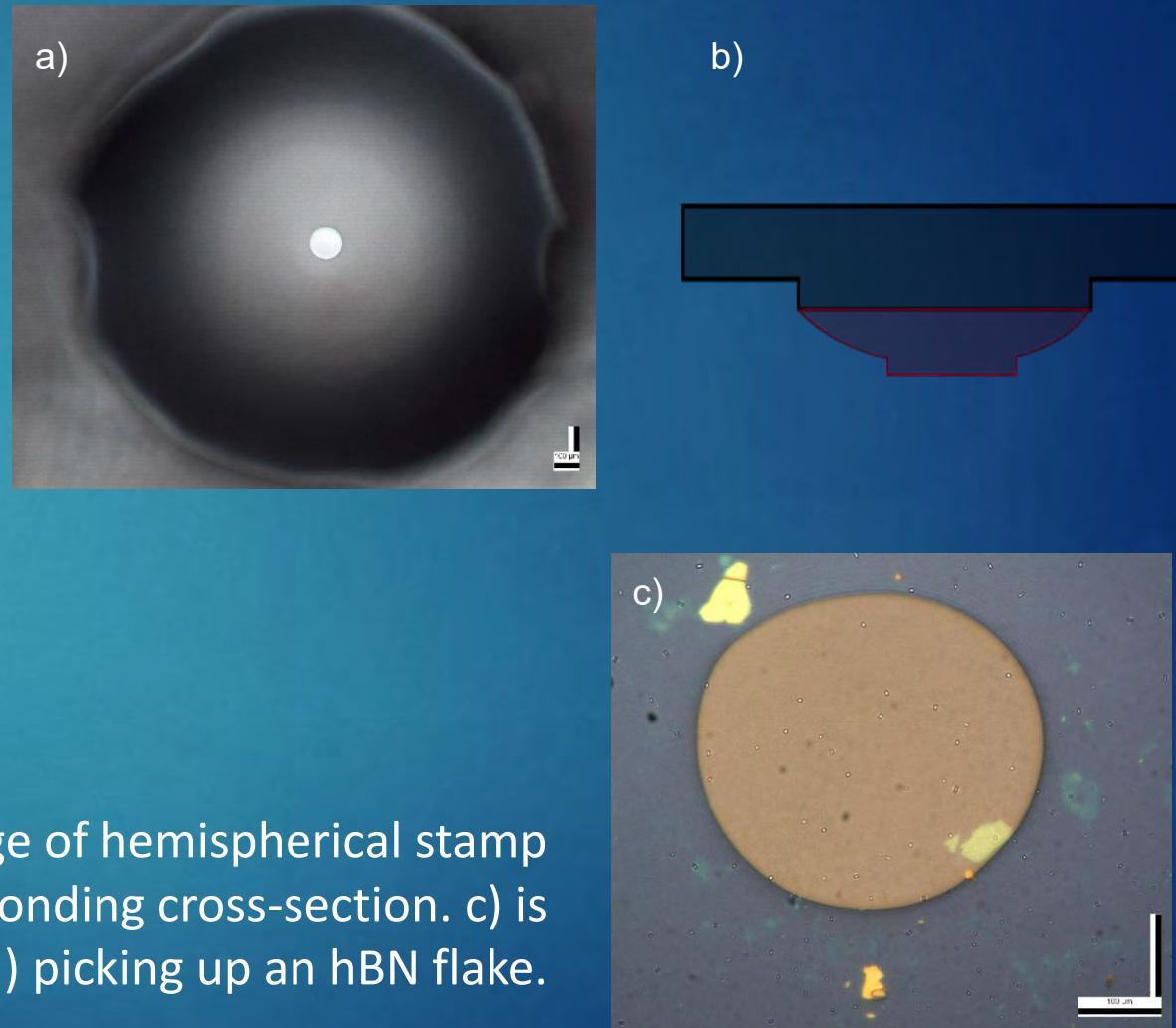
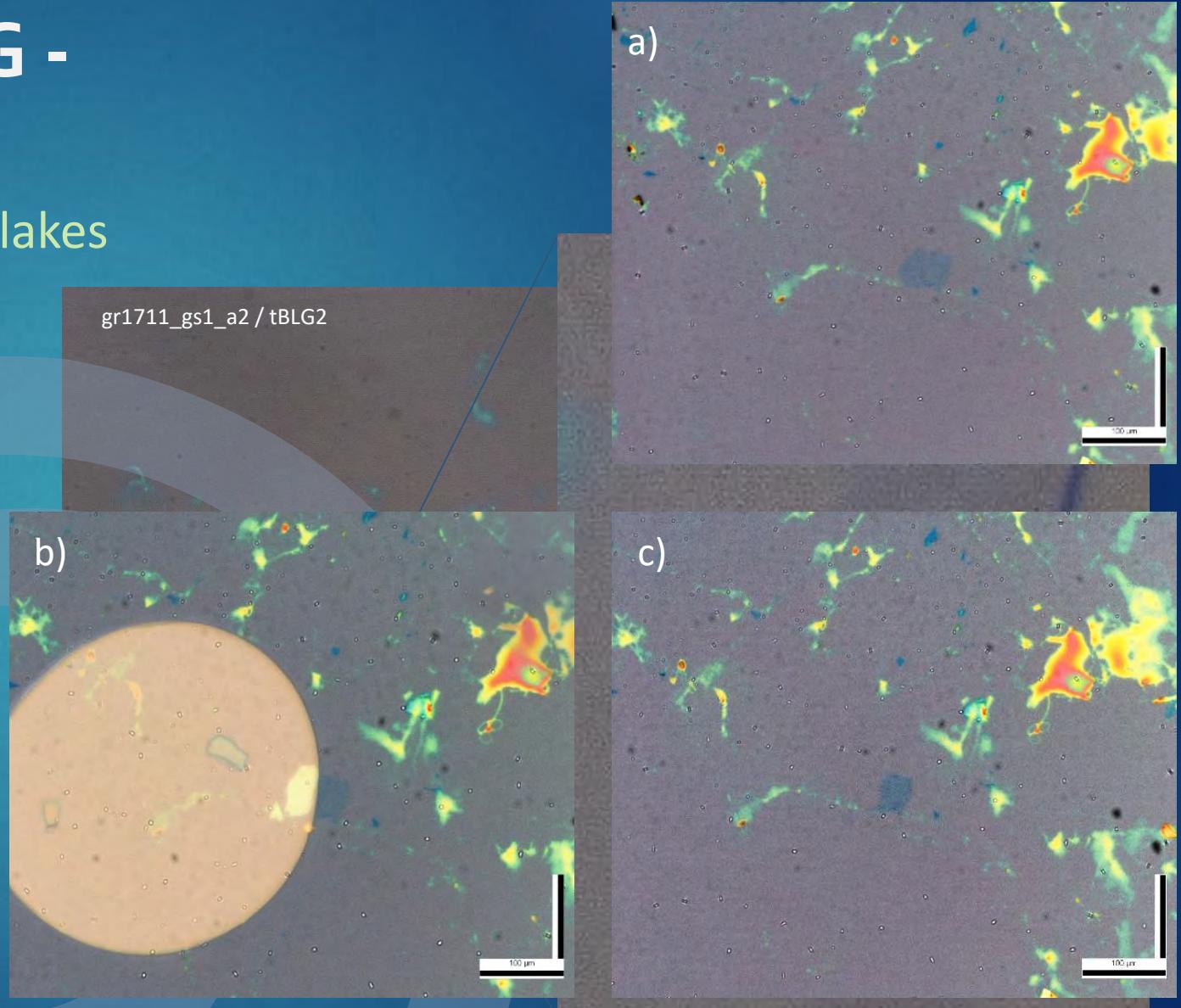


Figure 4.13: Convexo-rect. stamp. a) Optical image of hemispherical stamp with a cylindrical plateau at the tip and b) corresponding cross-section. c) is the optical image of (a) picking up an hBN flake.

PROCEDURE FOR TBLG -

1. Exfoliation of hBN and graphene flakes
2. Pickup of hBN
3. Tear Graphene
4. Pickup of 1st half of graphene

Fig 15: Optical image of a) graphene flake before tear-pickup, b) stamp with hBN in contact with half gr and c) other half of graphene left on substrate after tear.



PROCEDURE FOR TBLG -

2. Pickup of hBN
3. Tear Graphene
4. Pickup of 1st half of graphene
5. Twist and pickup of other half

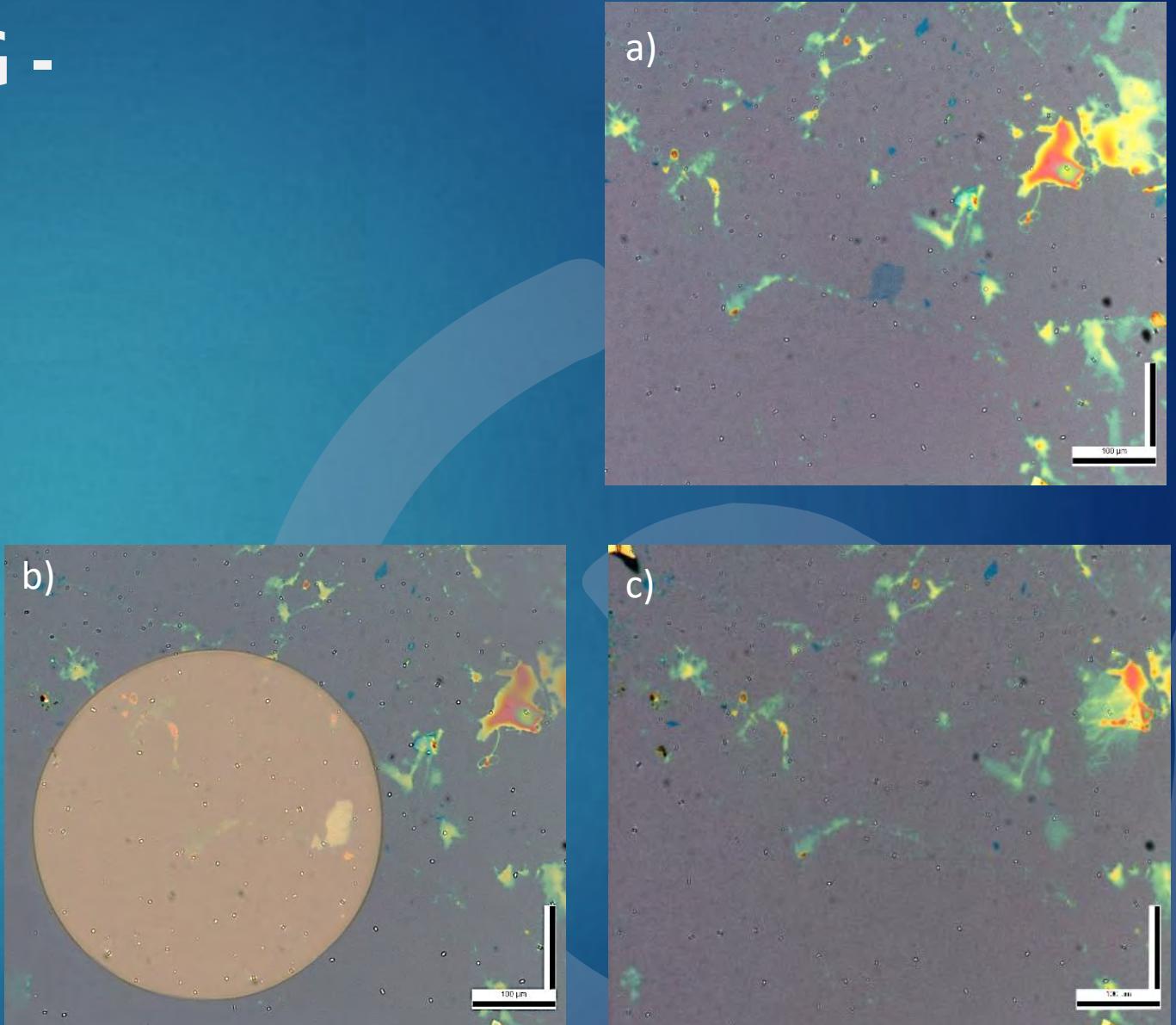


Fig 16: Optical image of a) graphene flake before final pickup, b) the twisted stamp containing hBN-gr in contact with the other half of gr and c) substrate after final pickup.

PROCEDURE FOR TBLG -

3. Tear Graphene
4. Pickup of 1st half of graphene
5. Twist and pickup of other half
6. hBN encapsulation and post processing

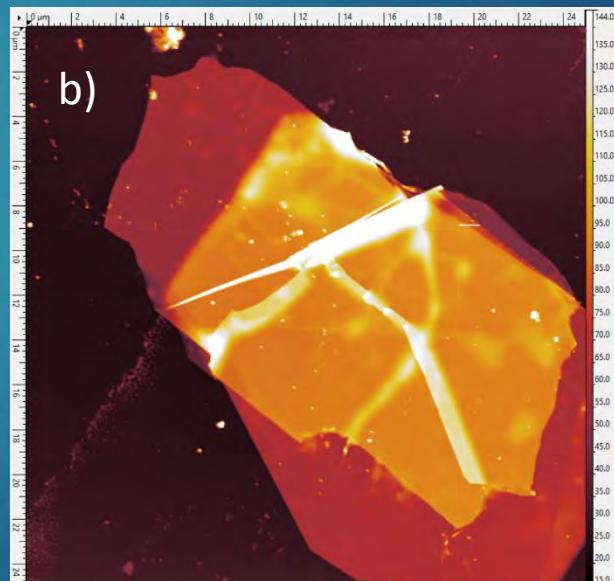
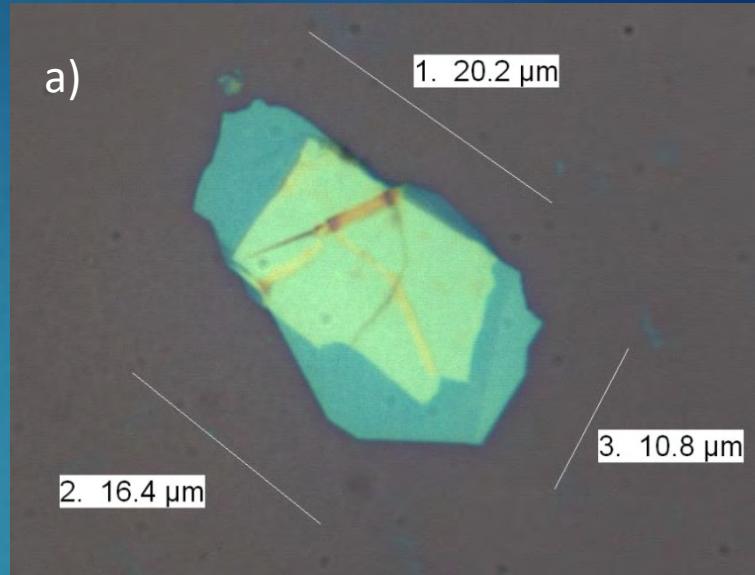


Fig 17: a) Optical Image of the final stack and b) AFM image of the same

PROCEDURE FOR TBLG -

7. Analysis

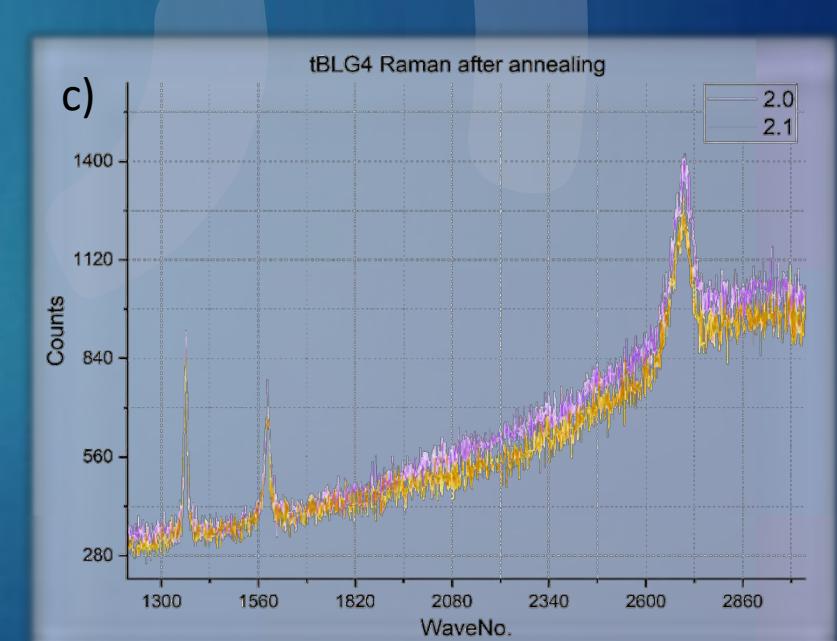
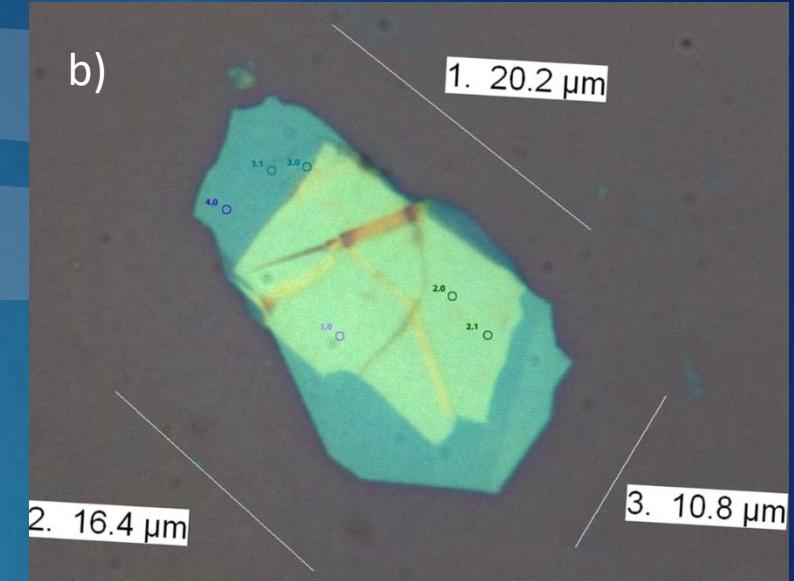
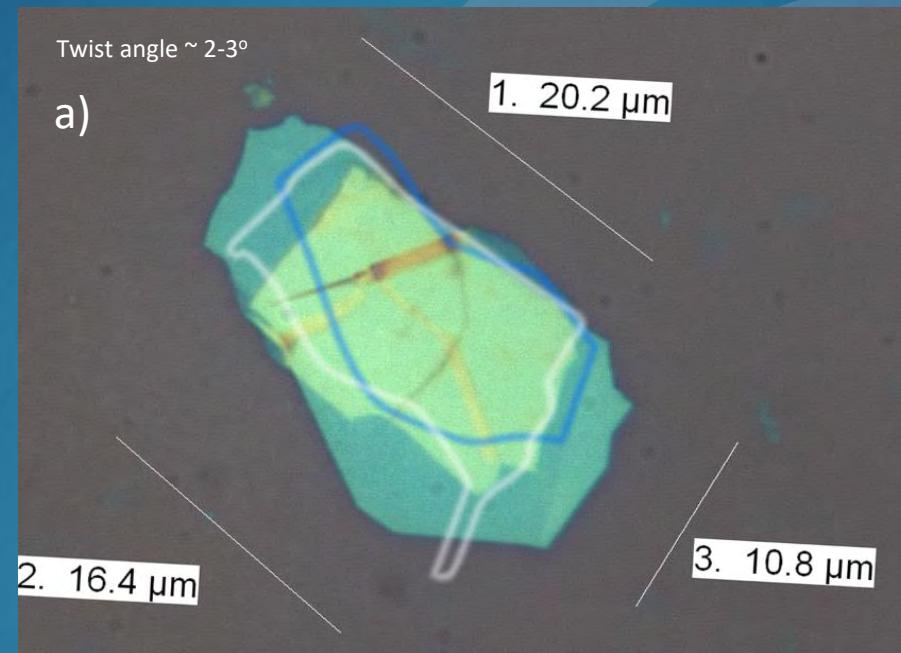


Fig 18: a) Optical Image with overlay of the gr flakes. The twist is estimated from the images b) Stack with markings on Raman spectrum sites c) Relevant Raman Spectrum.

SUMMARY OF MY WORK

- Clean tearing edge by use of AFM
- Innovative solution to the clean interface problem leads to ultra clean interface.
- Standardised the dry stacking procedure for tear and stack.
- Easily generalisable for a MAtBLG.

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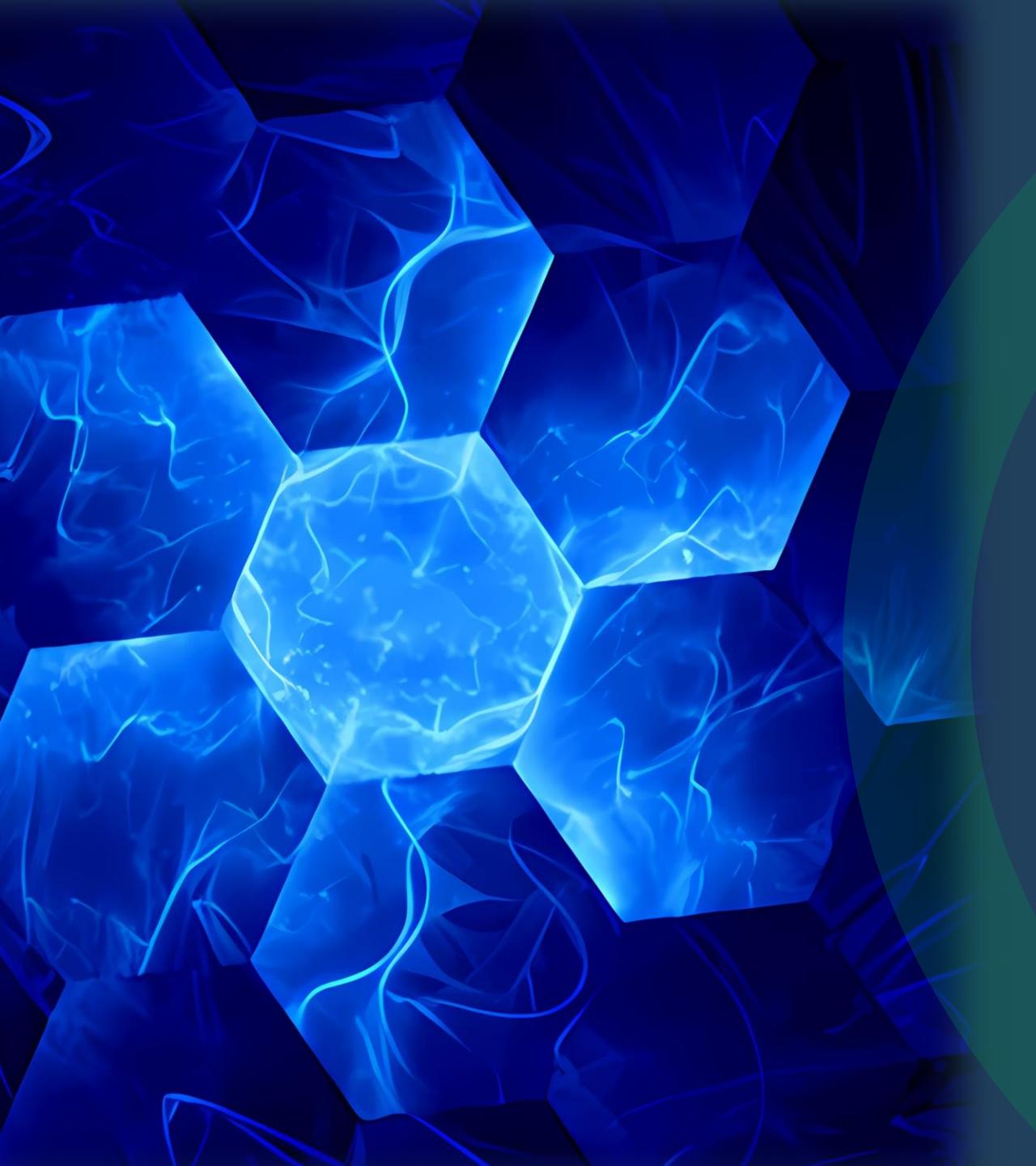
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Image credit: SEP Hall Thruster, NASA

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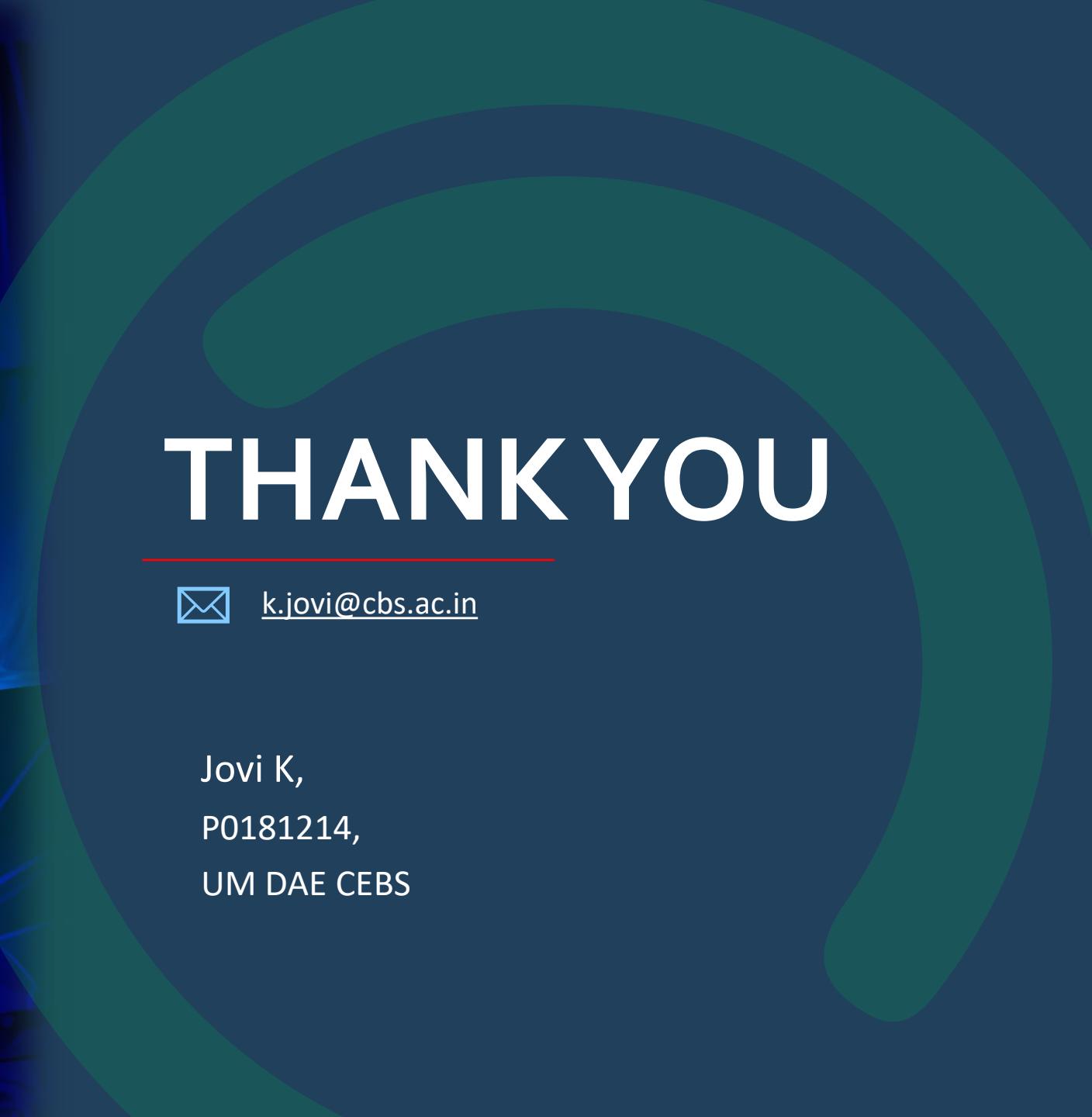
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Image credit: [here](#)



THANK YOU

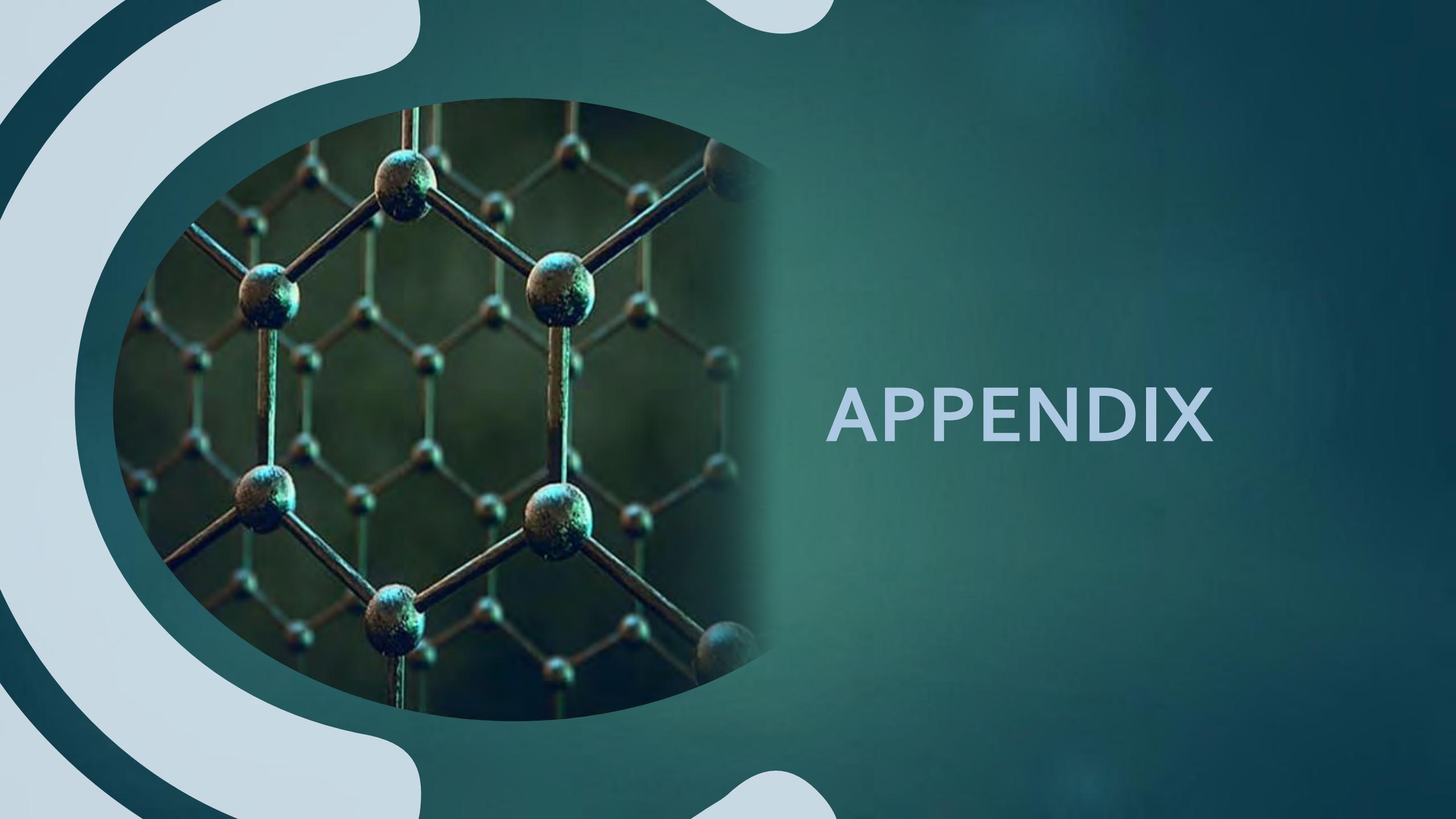
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P0181214,
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THE END





APPENDIX

SLG – MOIRE SUPERLATTICE:

IMAGE

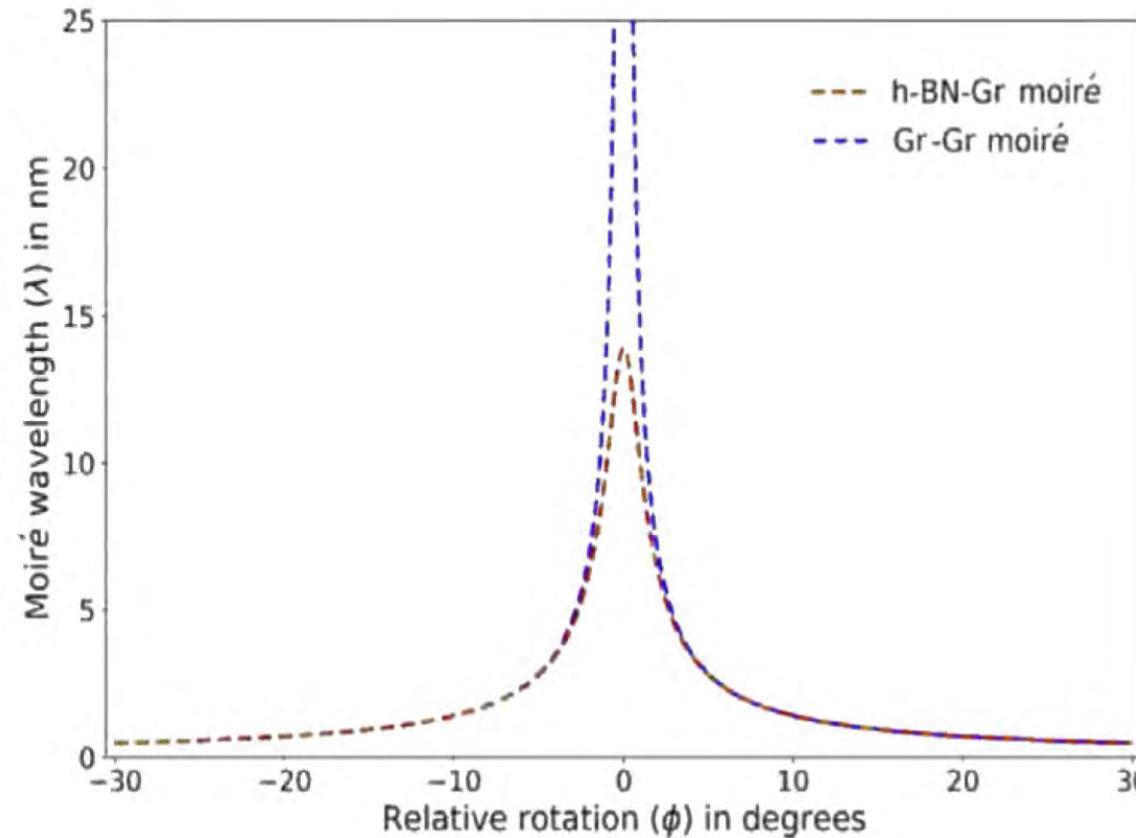


Figure 2.2: Energy Band in Graphene: a) Plot of Energy band in reciprocal space. b) is the corresponding Reciprocal space.



CAPTION

Cao, Y. et al. Unconventional superconductivity in magic-angle graphene superlattices. Nature 556, 43–50 (2018).

FABRICATION MAGIC ANGLE TBLG:

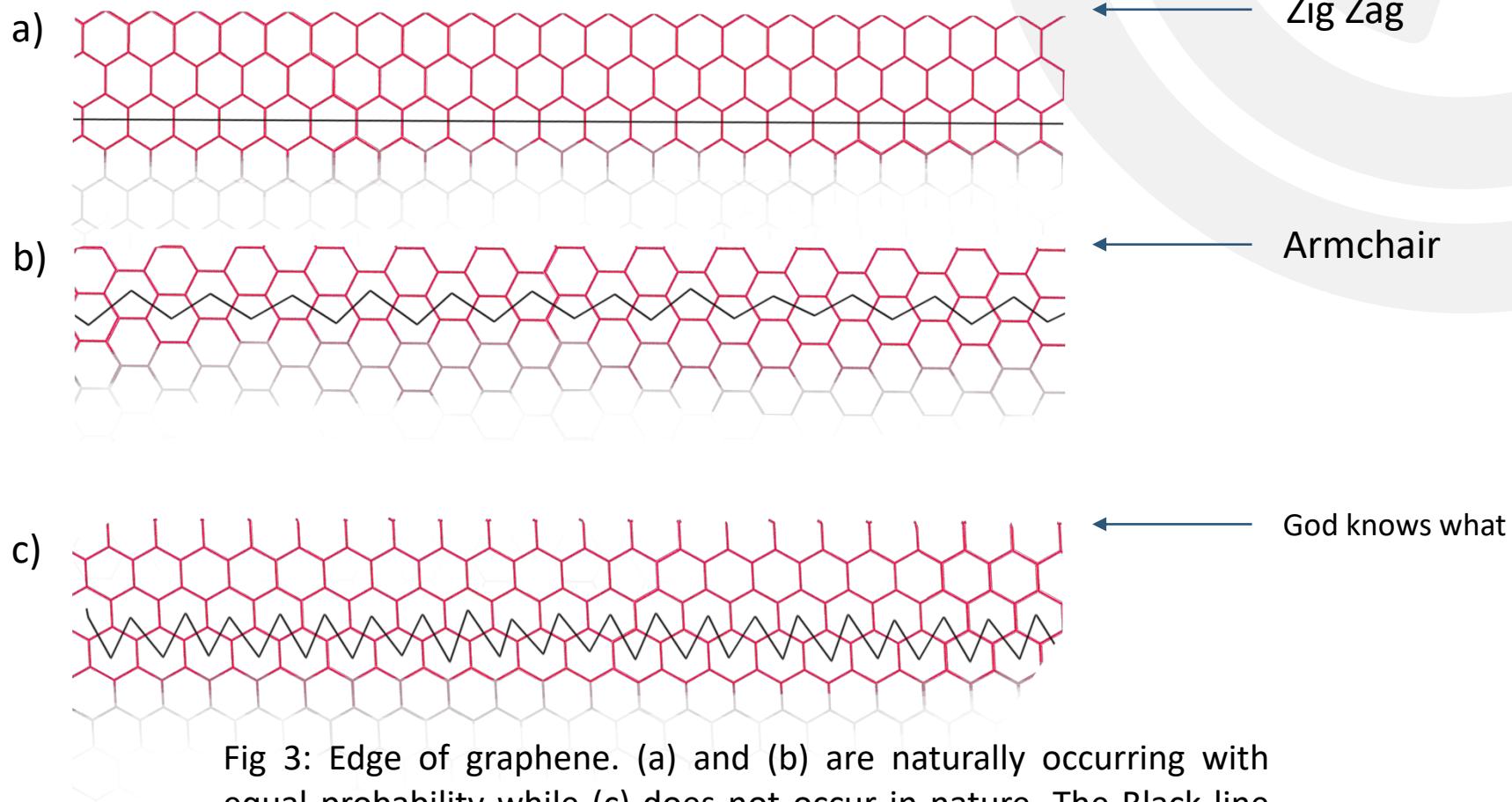


Fig 3: Edge of graphene. (a) and (b) are naturally occurring with equal probability while (c) does not occur in nature. The Black line represent the bond cu

SLG – DIRAC CONES:

IMAGE

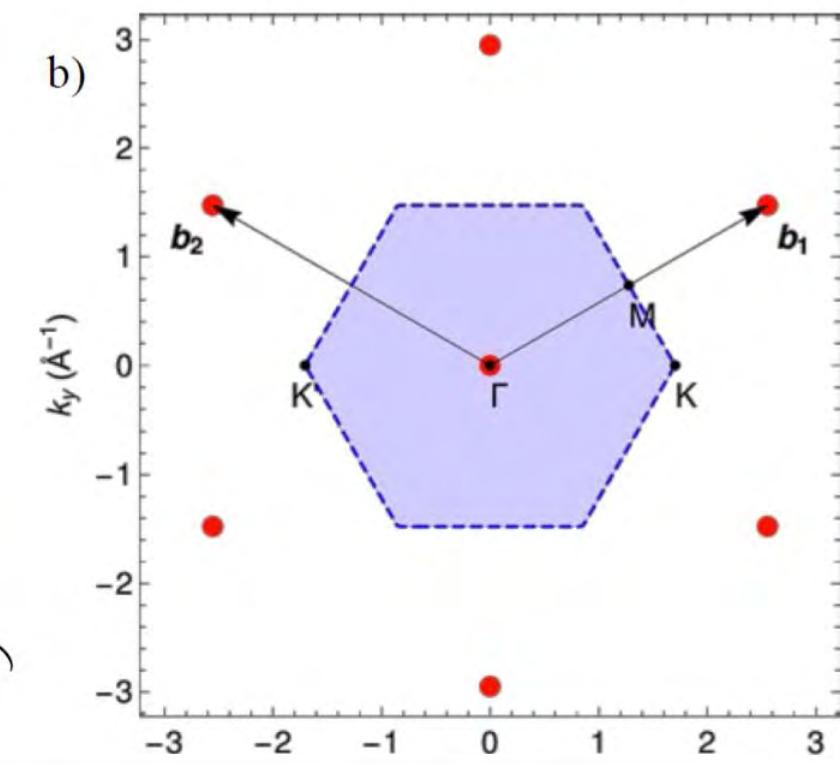
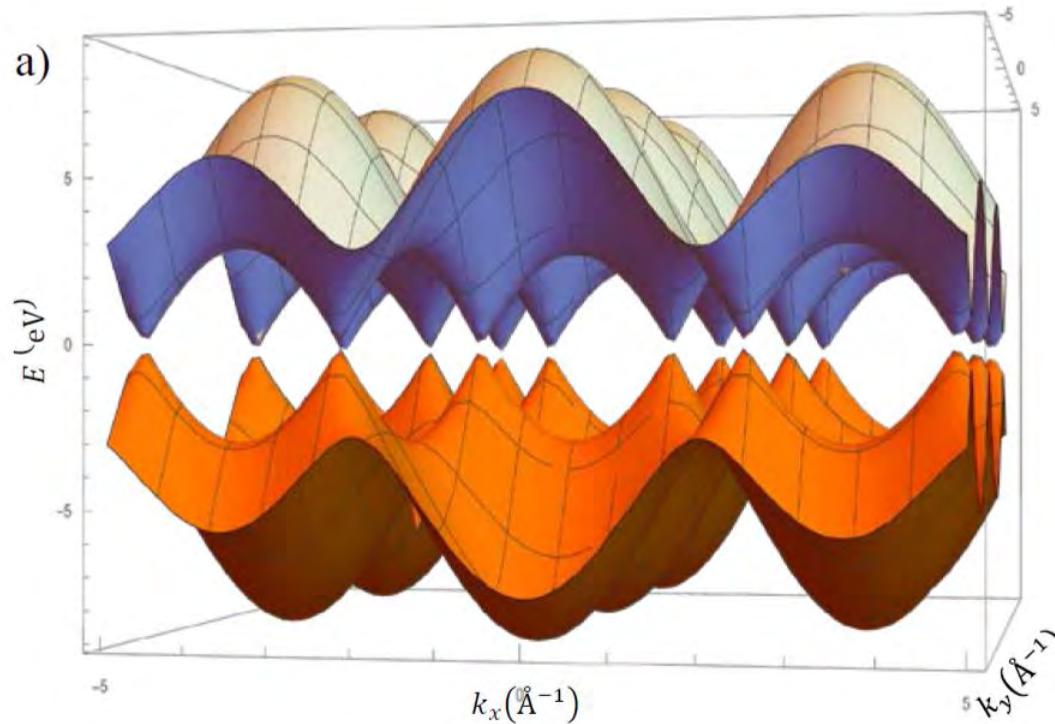
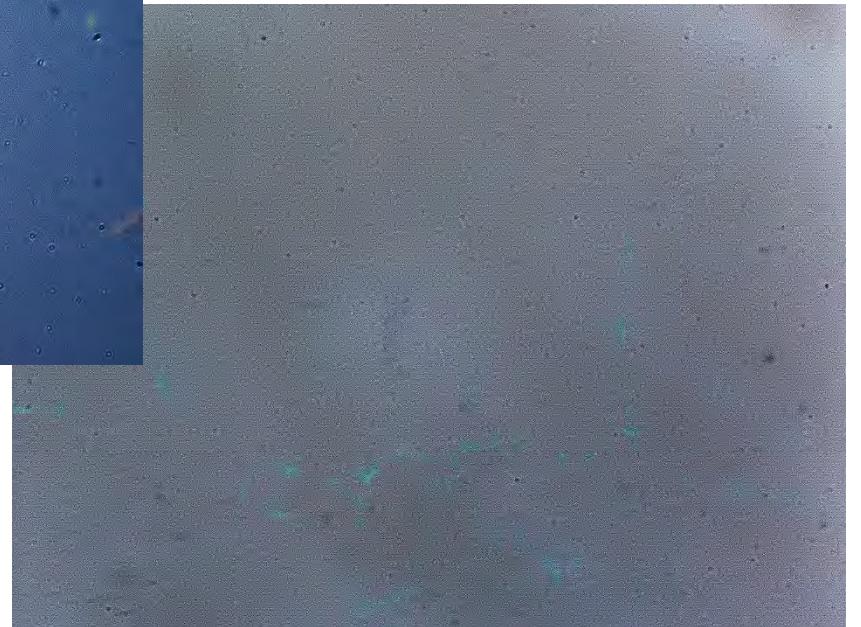
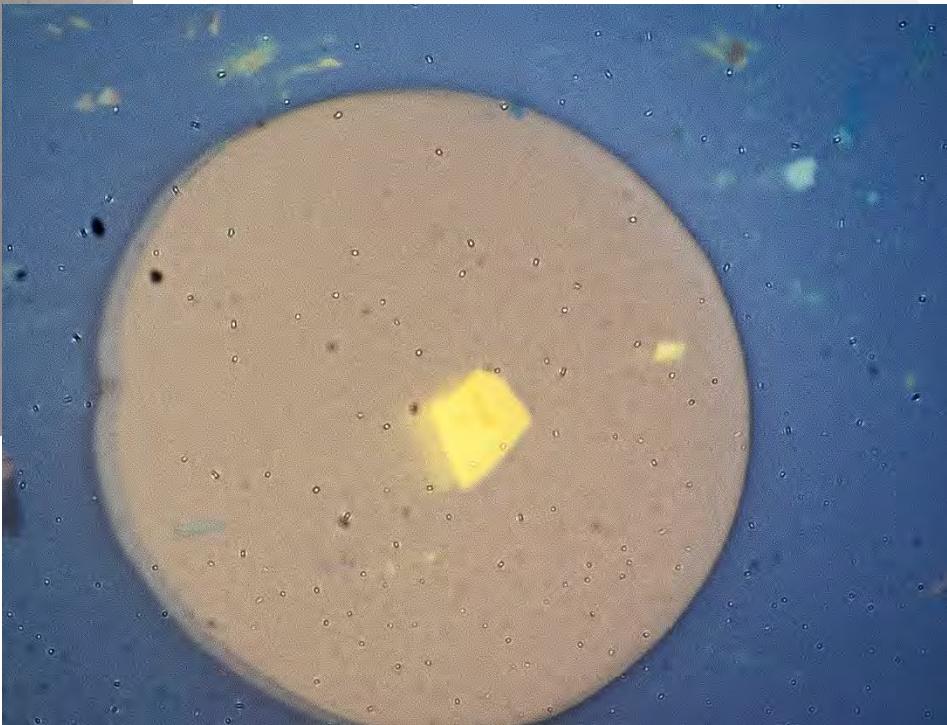
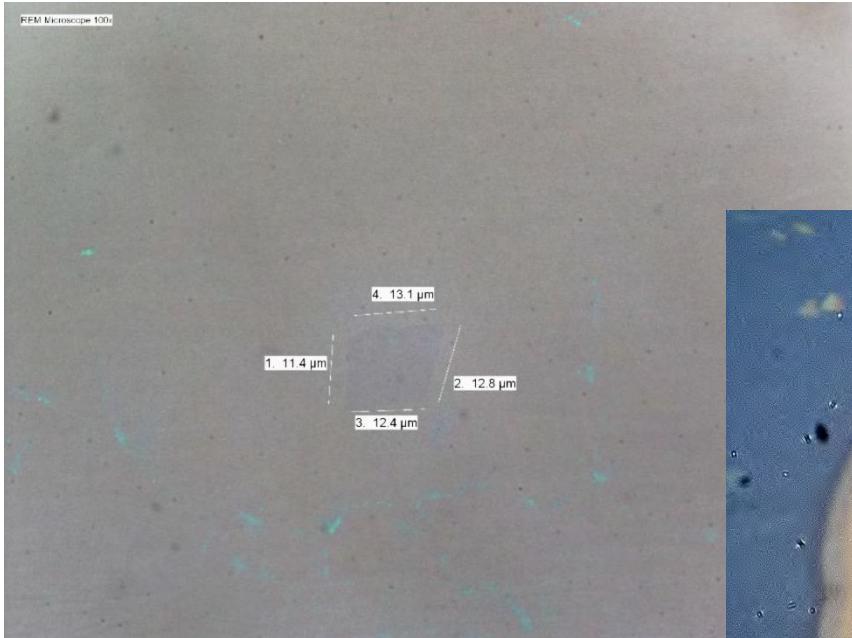


Figure 2.2: Energy bands in the reciprocal space

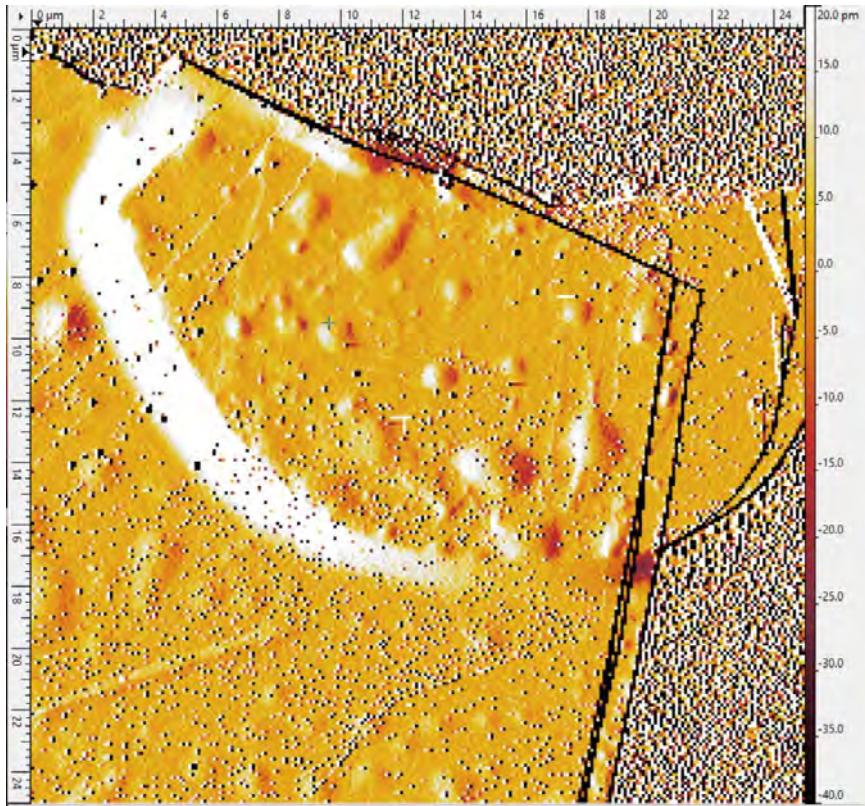
$$E(\mathbf{k}) = \pm t \sqrt{4 \cos\left(\frac{\sqrt{3}}{2} d k_x\right) \cos\left(\frac{3}{2} d k_y\right) + 2 \cos(\sqrt{3} d k_x) + 3}$$

Cao, Y. et al. Unconventional superconductivity in magic-angle graphene superlattices. Nature 556, 43–50 (2018).

tBLG_1 Angle ~24°



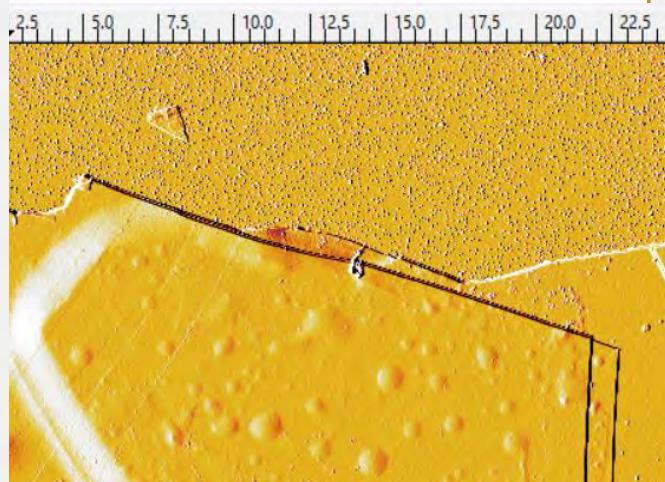
tBLG_1 Angle ~24°



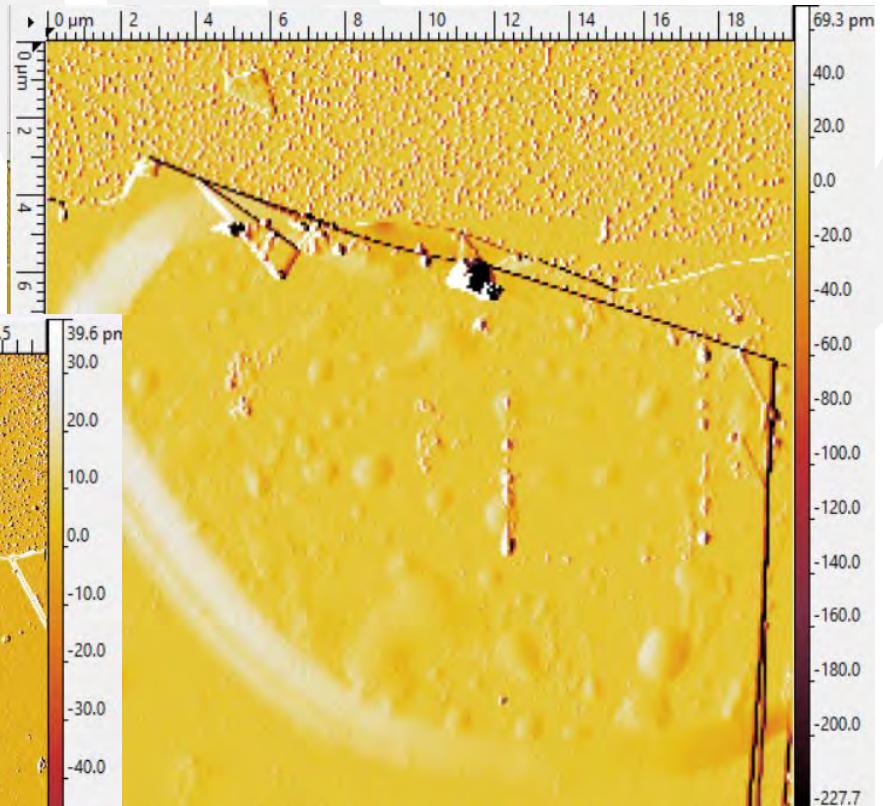
Annealing at
300° for 3 hrs.



15.0
17.5
20.0
22.5



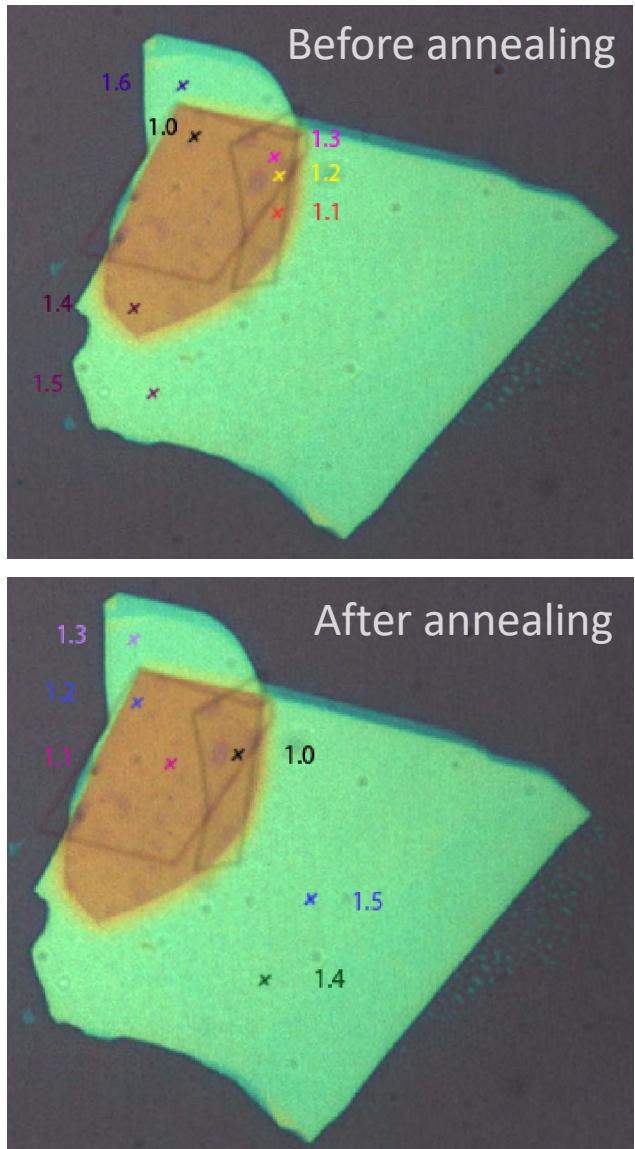
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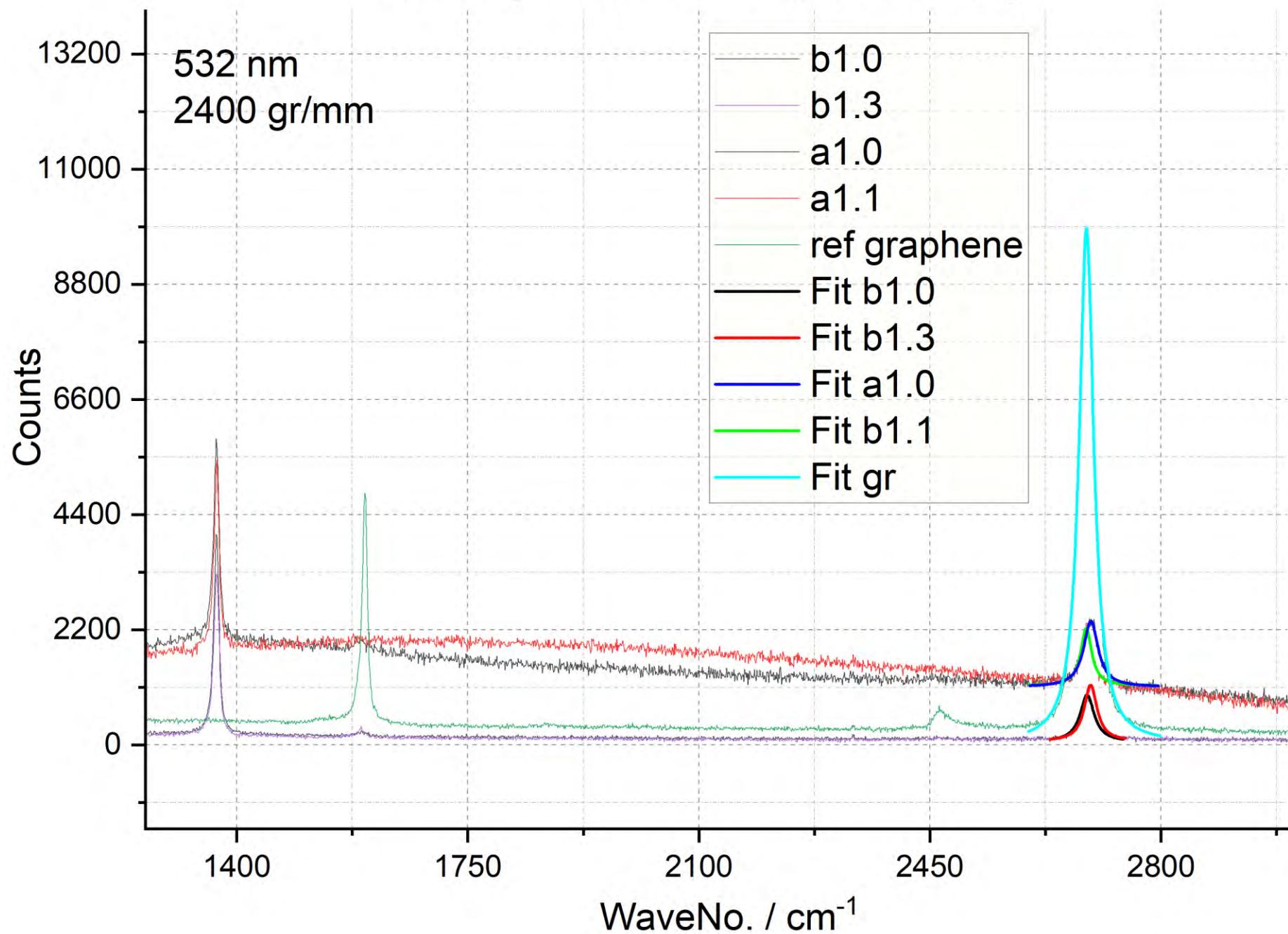
AFM Ironing

<http://www.int.kit.edu/krupke-group>

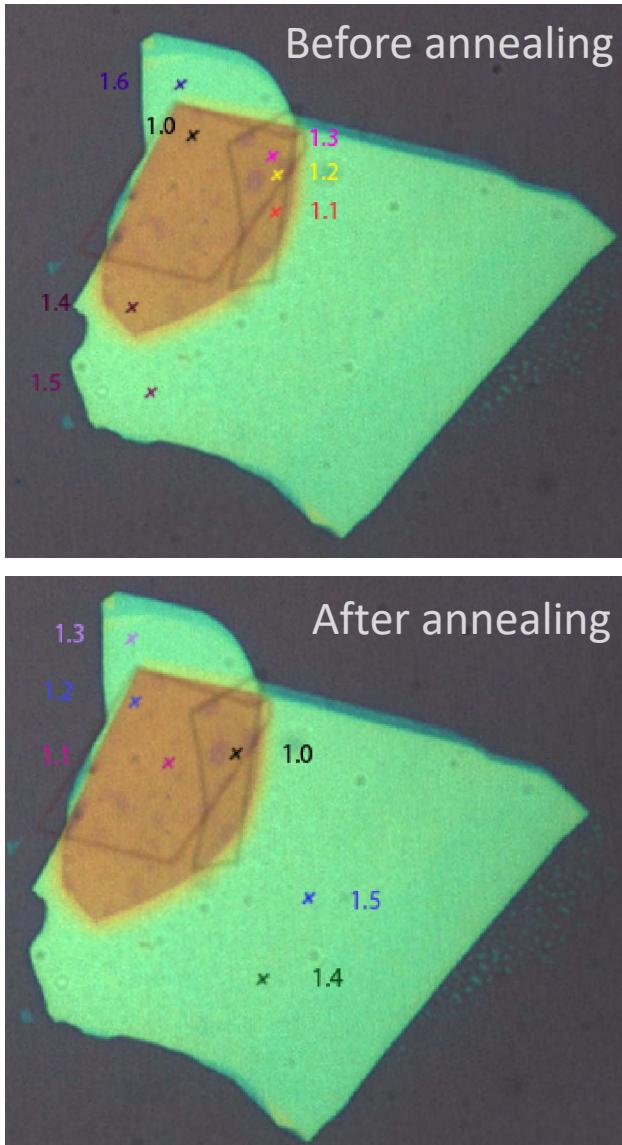
tBLG_1 Angle ~24°



tBLG spectrum before after annealing



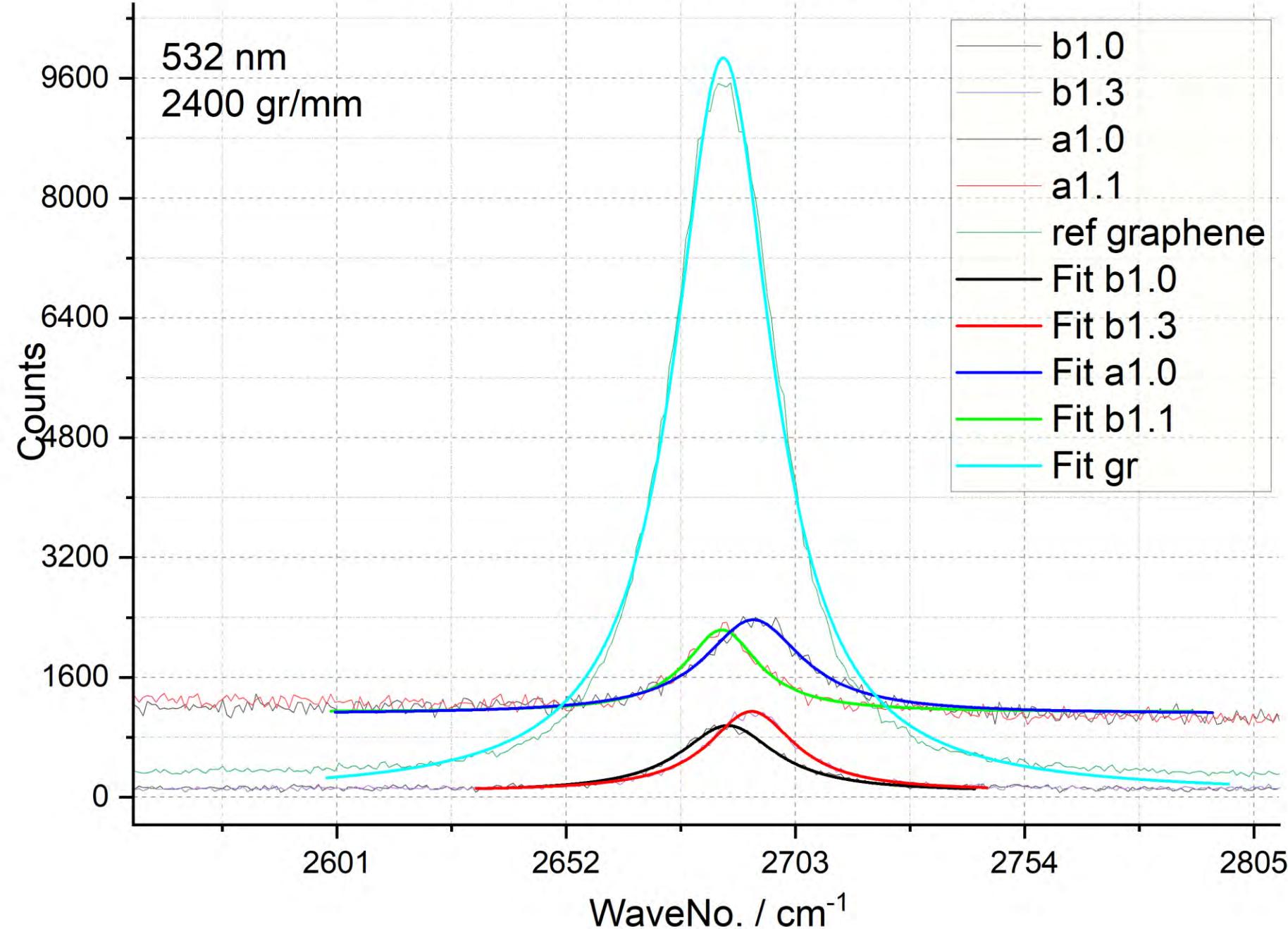
tBLG_1 Angle $\sim 24^\circ$



24-04-2023

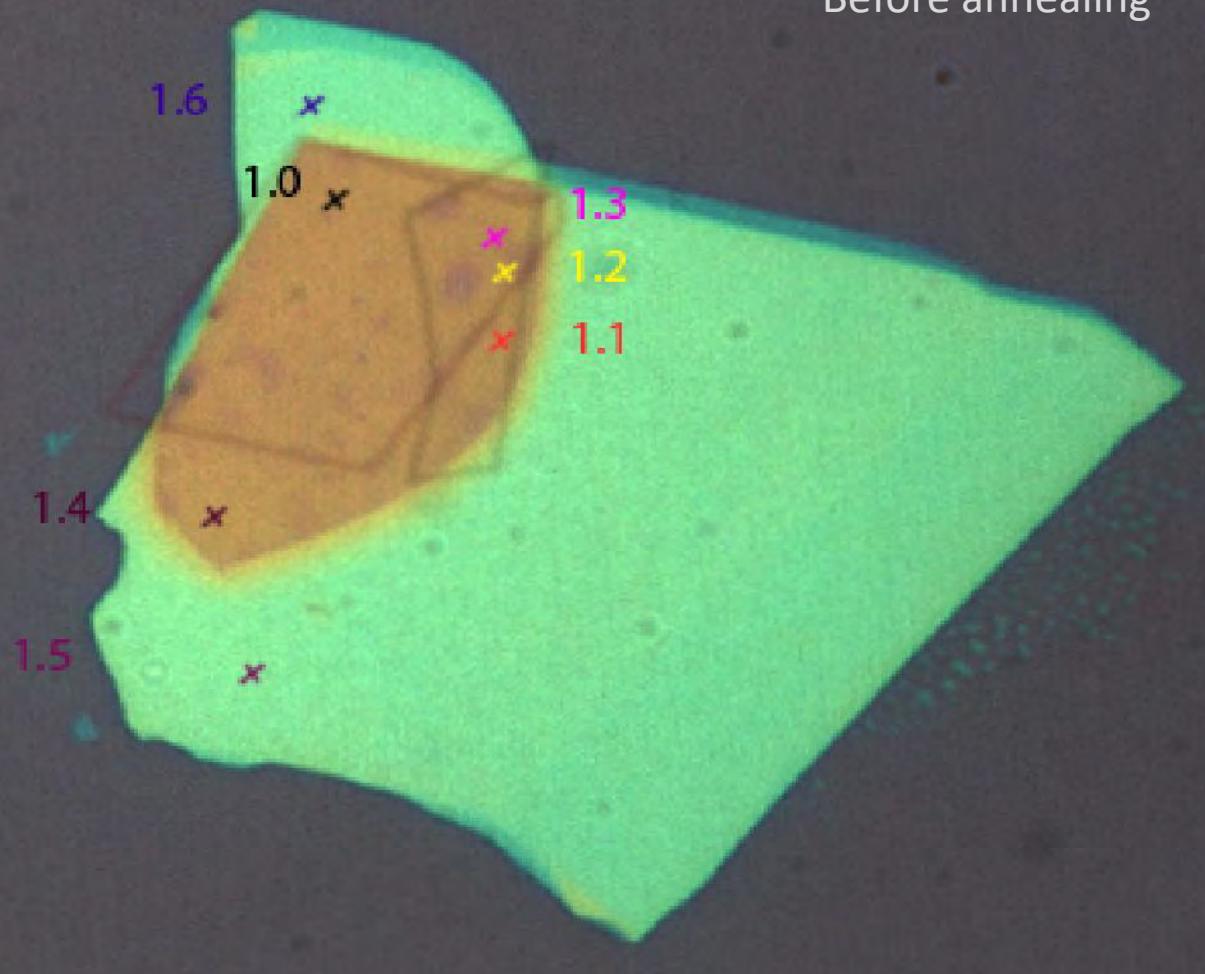
JOVI K

tBLG spectrum before after annealing

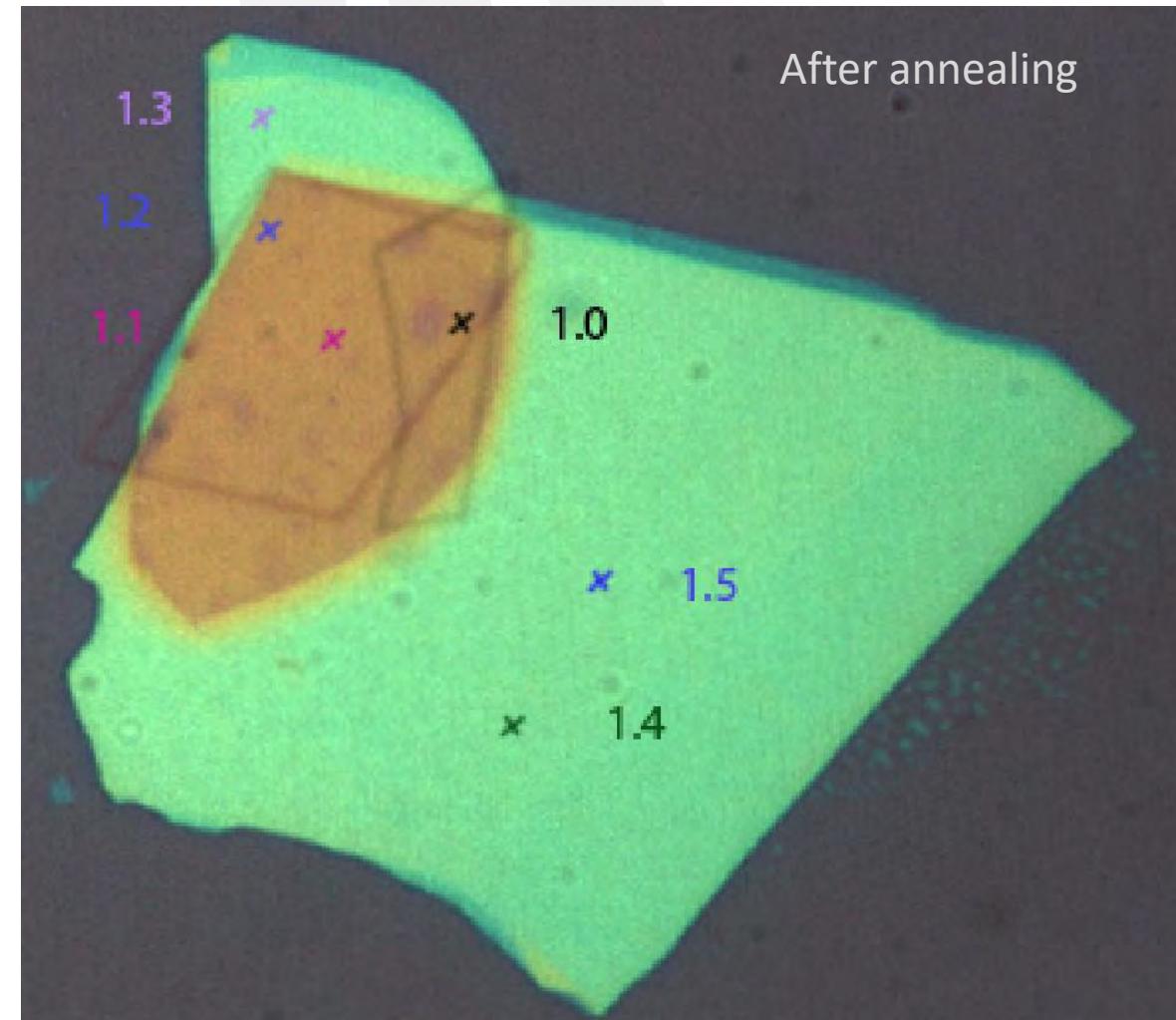


5% Power

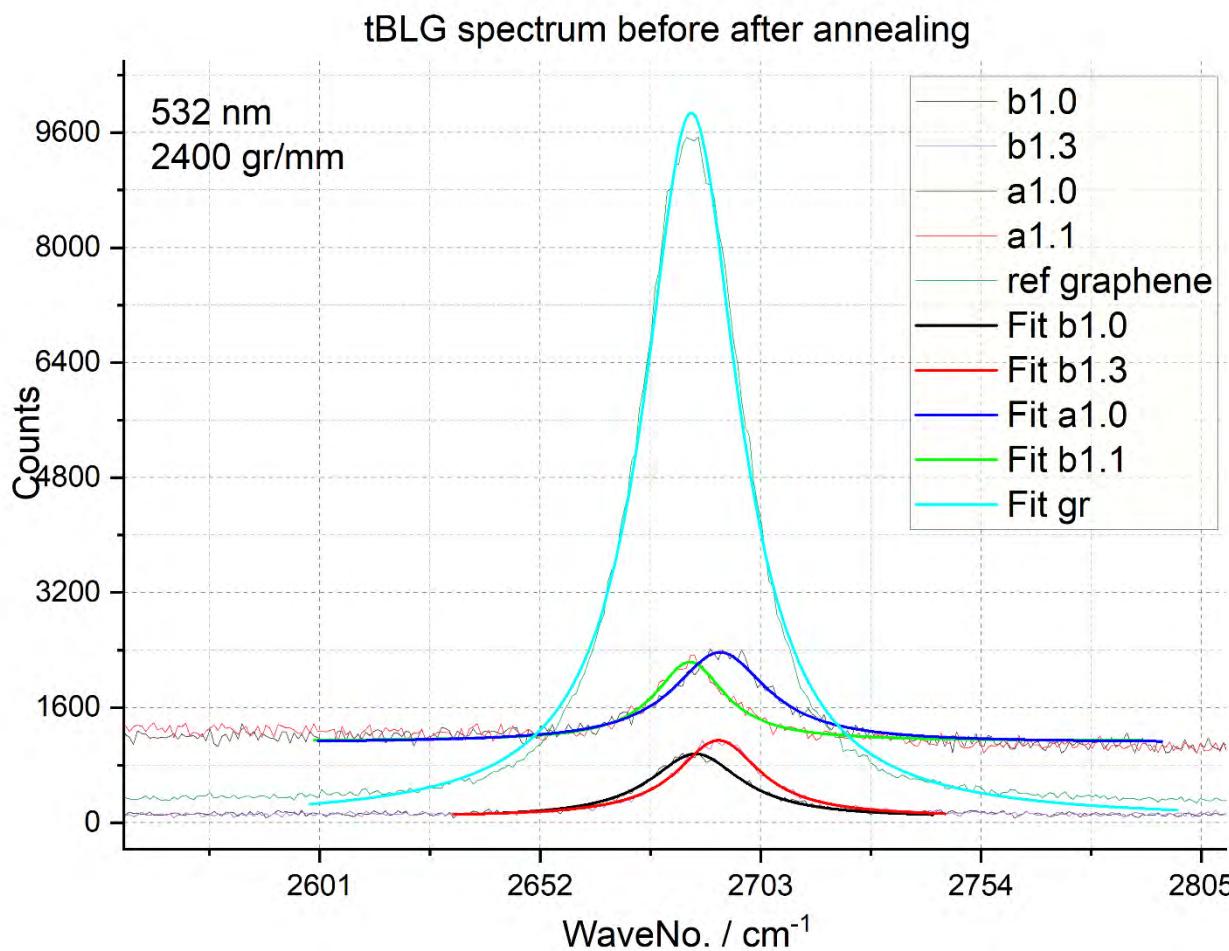
Before annealing



After annealing



tBLG Angle ~24°

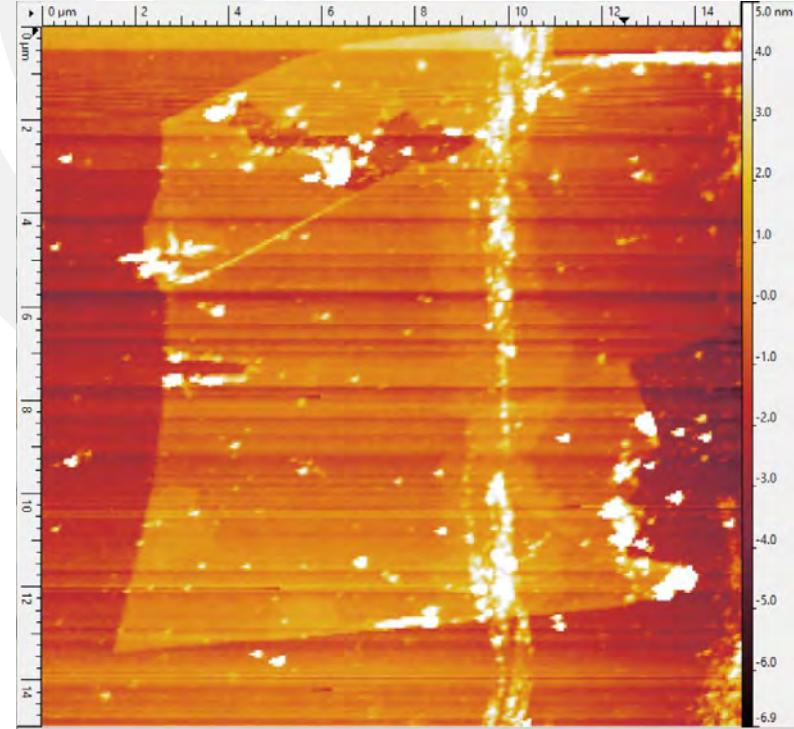
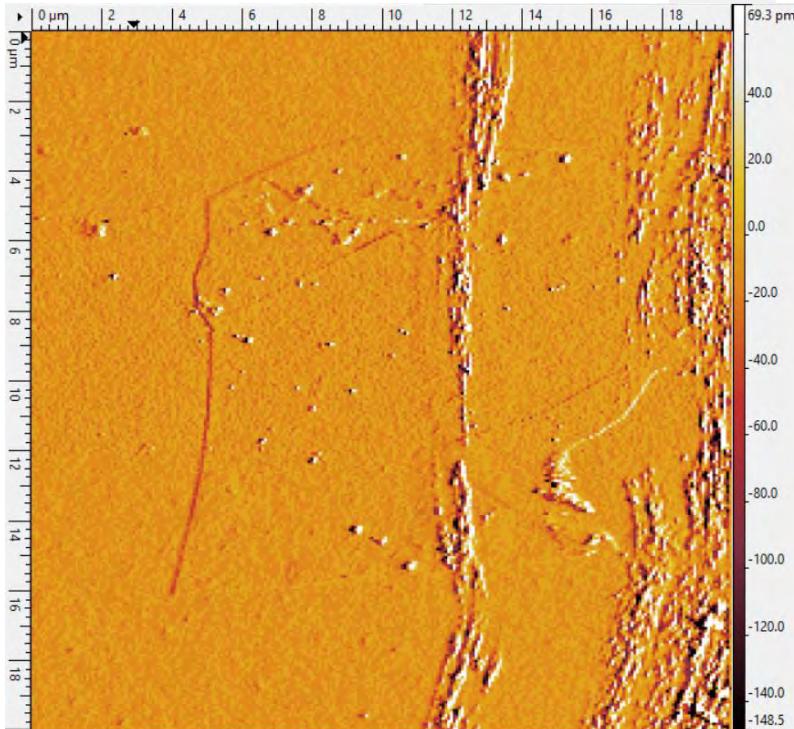
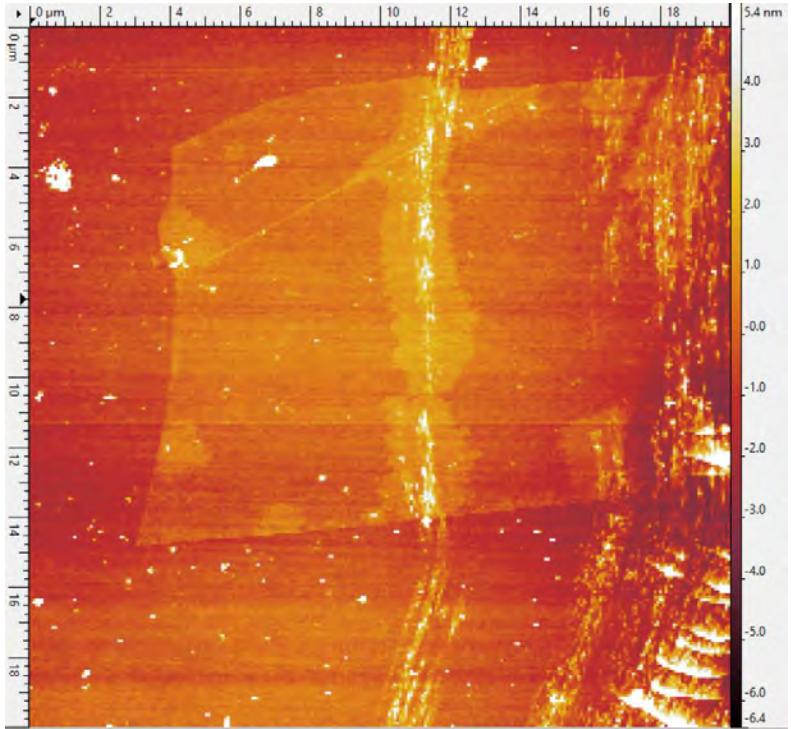


Site	Comment	Centre	FWHM	COD
ref	sLG	2686.97147	26.6696	0.99631
b1.0	Gr stack	2687.27108	25.9488	0.98766
b1.3	tBLG	2693.26407	23.5229	0.99223
a1.0	tBLG	2693.63354	24.6959	0.94786
a1.1	Gr stack	2686.63373	19.9056	0.91869

- tBL has blueshift ~6 cm^{-1}
- Before after heat blueshift is same



AFM contact Tear

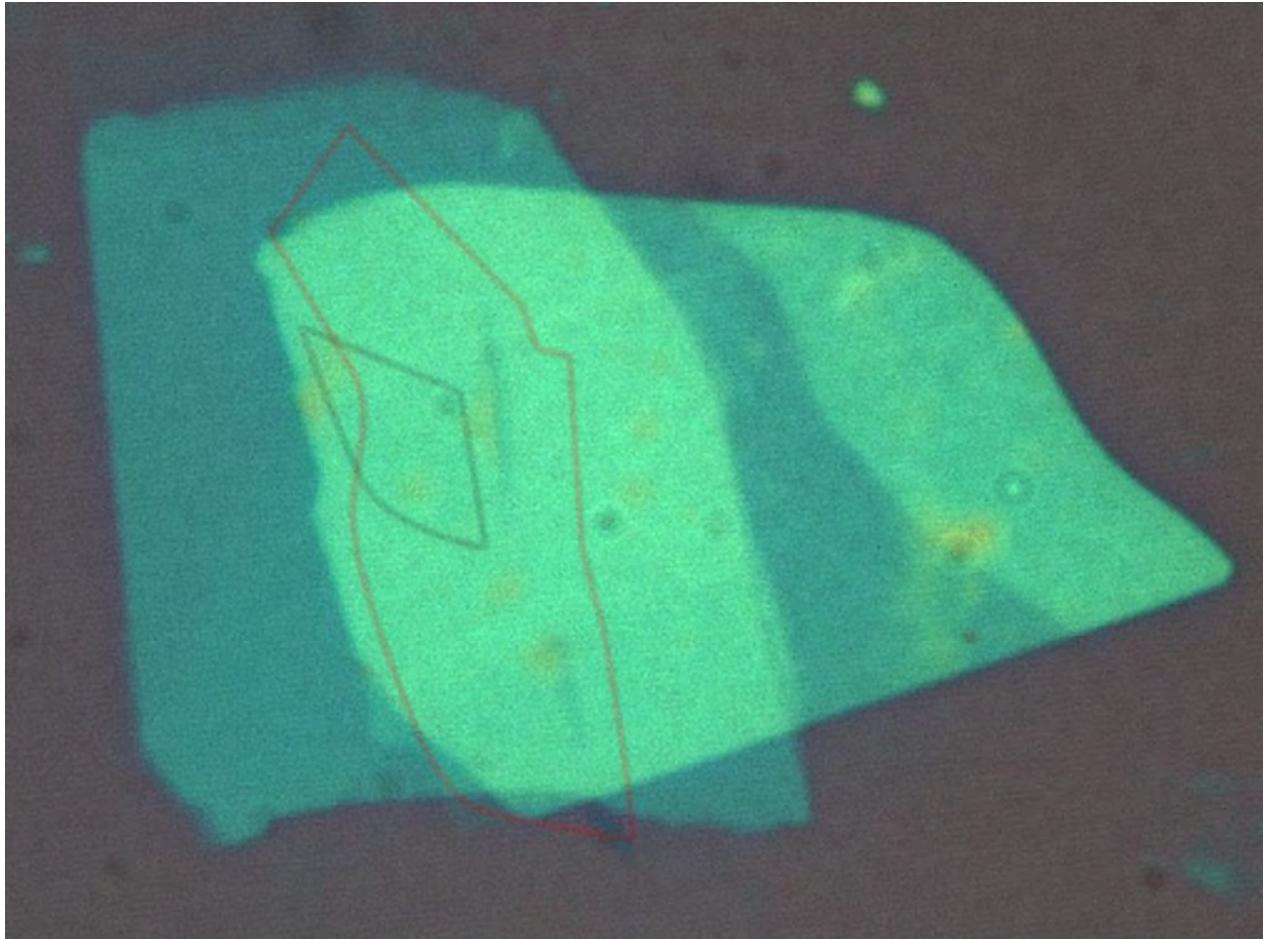


Tap before tear
IG – 0.5
PG – 5
Target – 310mV
Setpoint – 270mV

Contact before tear
IG – 5
PG – 10
Setpoint – 0.6 V

Tap after tear
IG – 0.5
PG – 5
Target – 310mV
Setpoint – 240mV

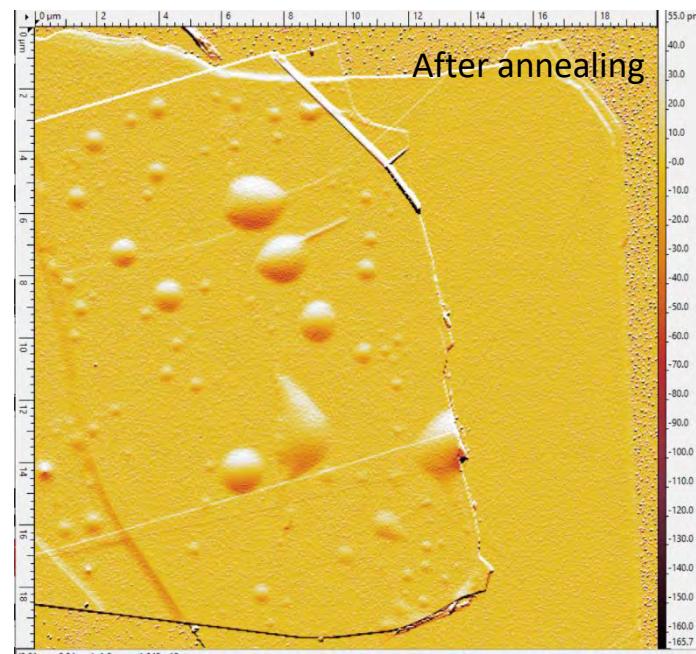
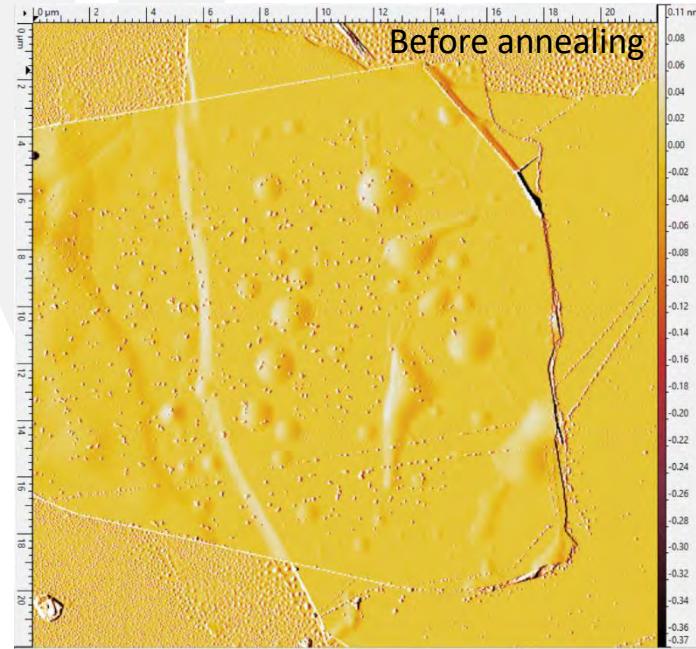
tBLG_2 Expected angle ~ 3°



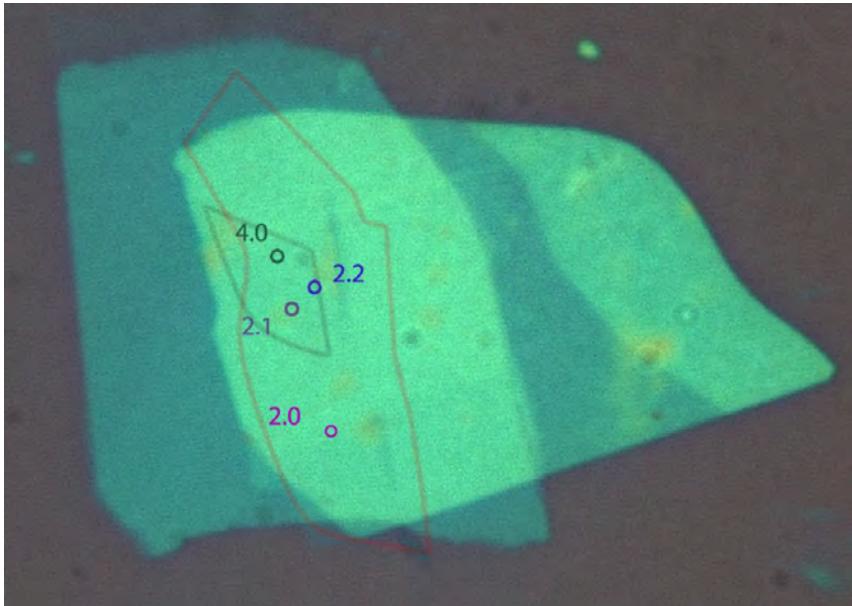
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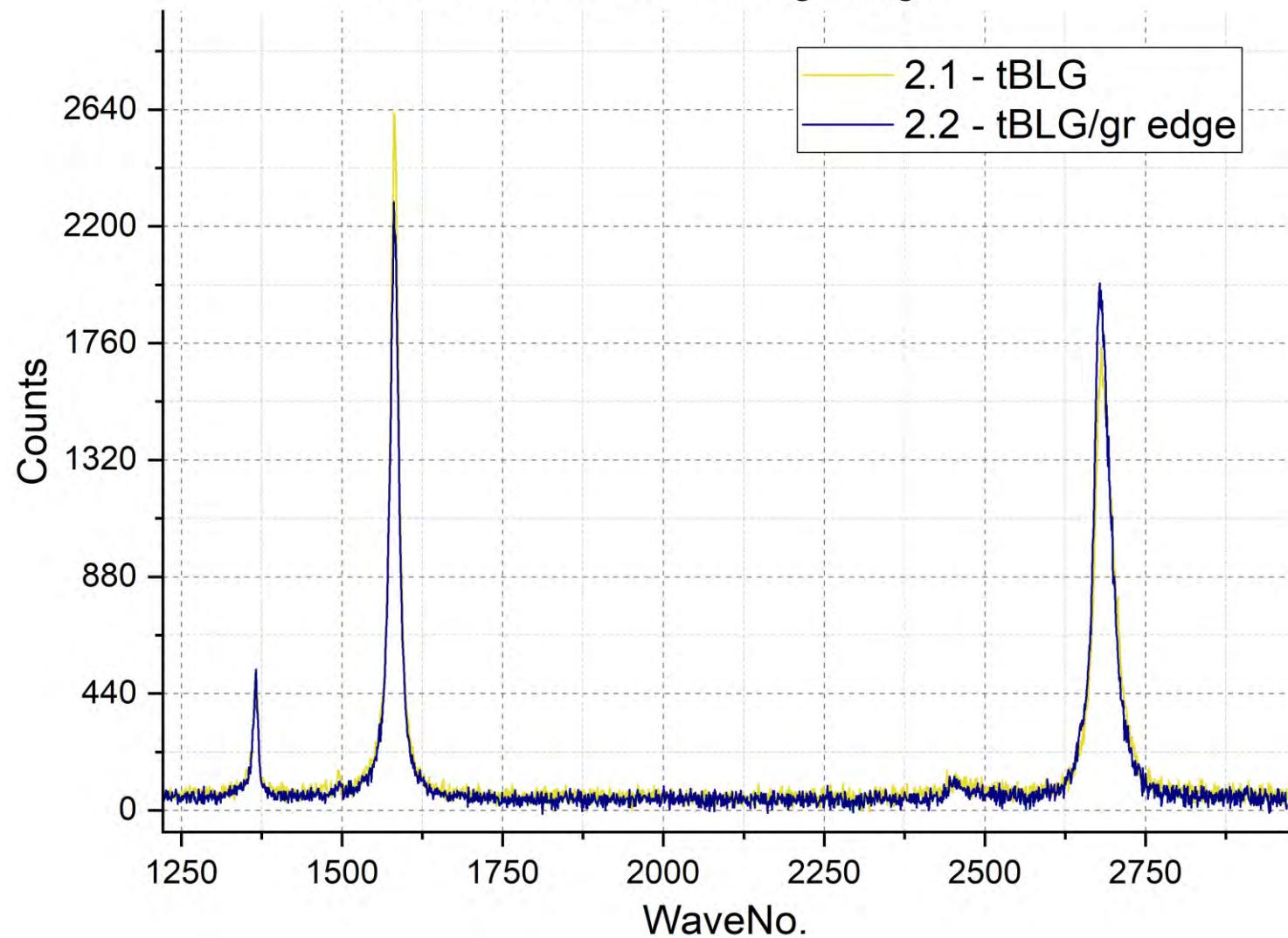
UM DAE CEBS



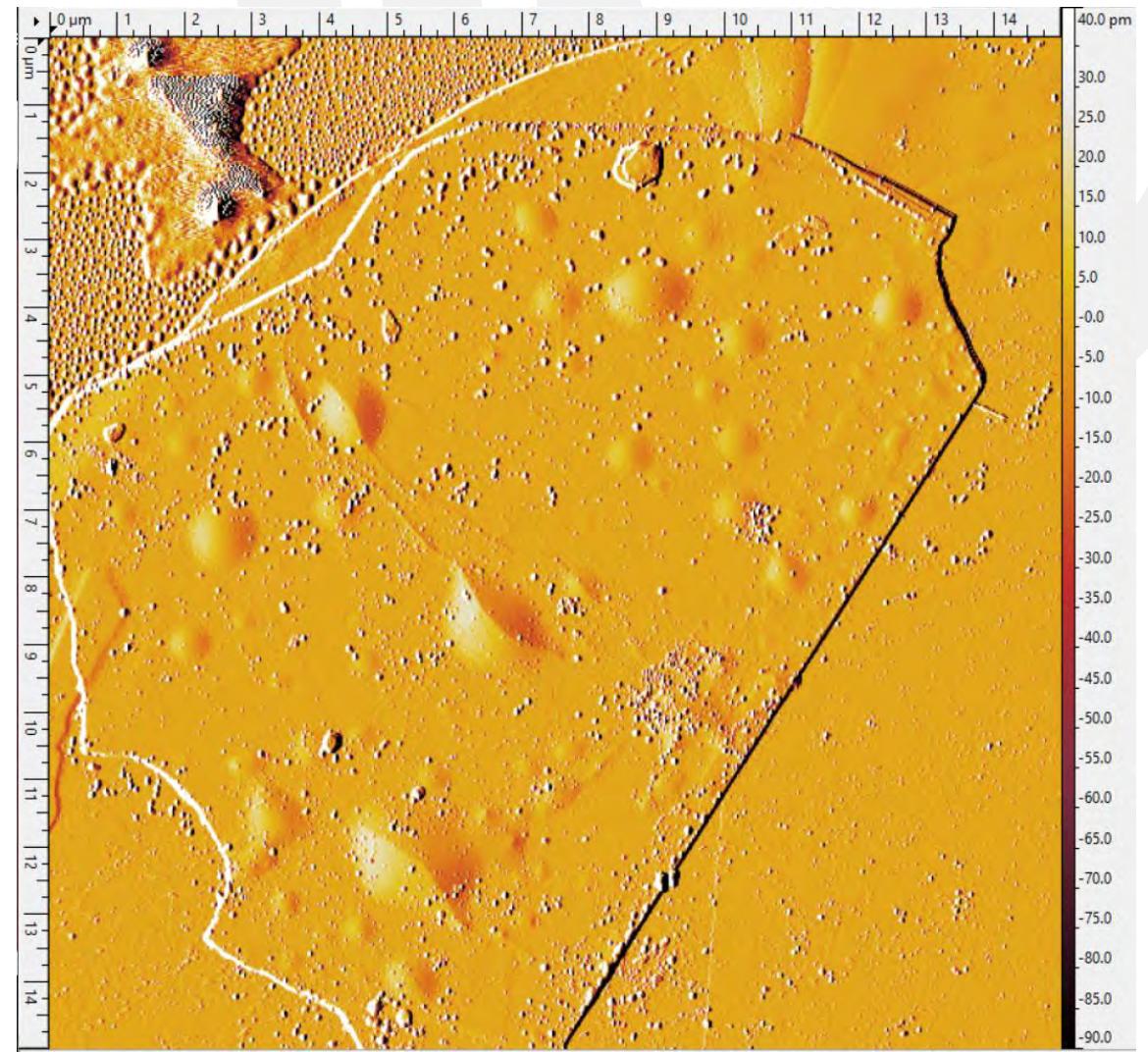
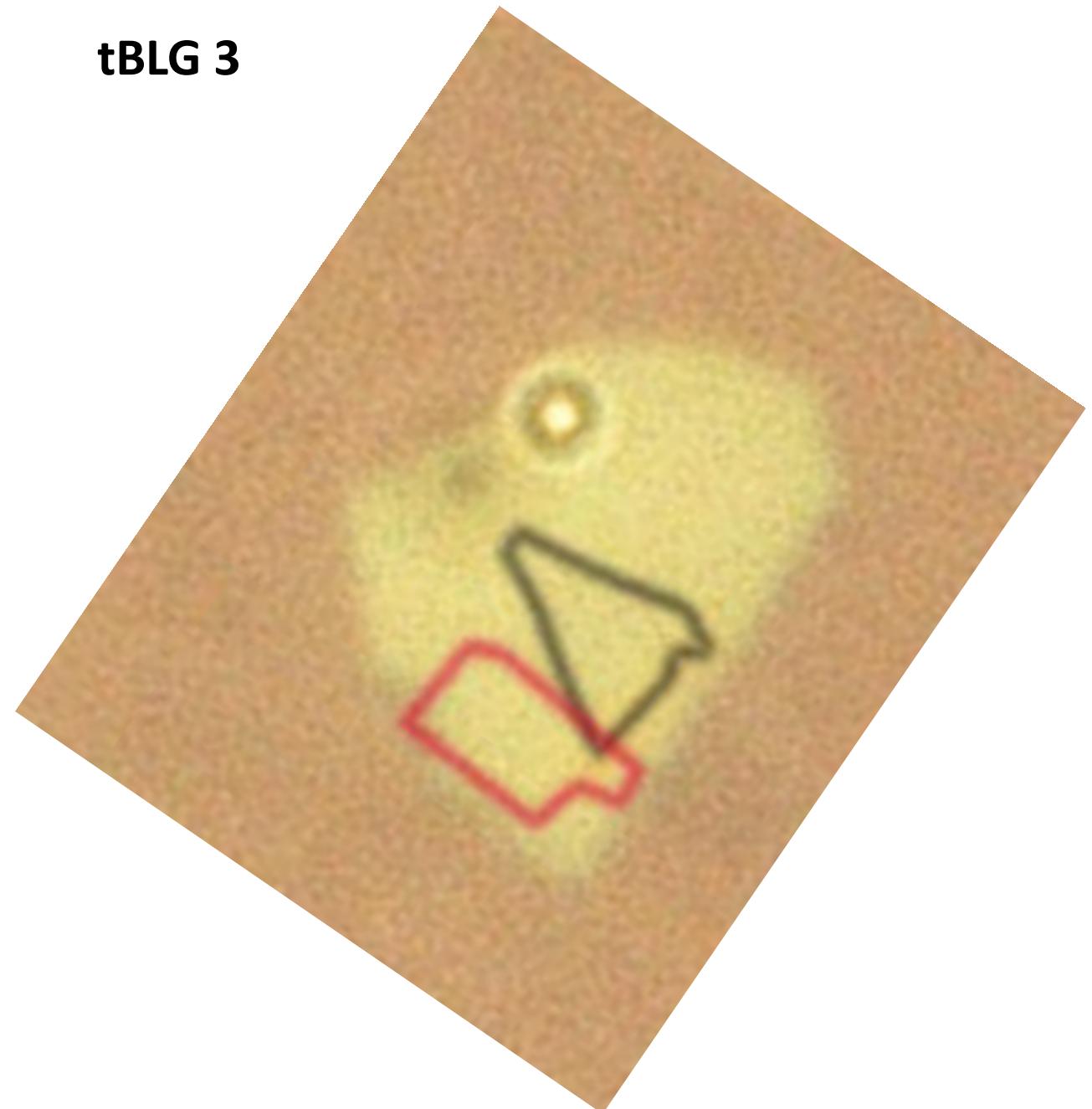
tBLG_2 Expected angle $\sim 5^\circ$



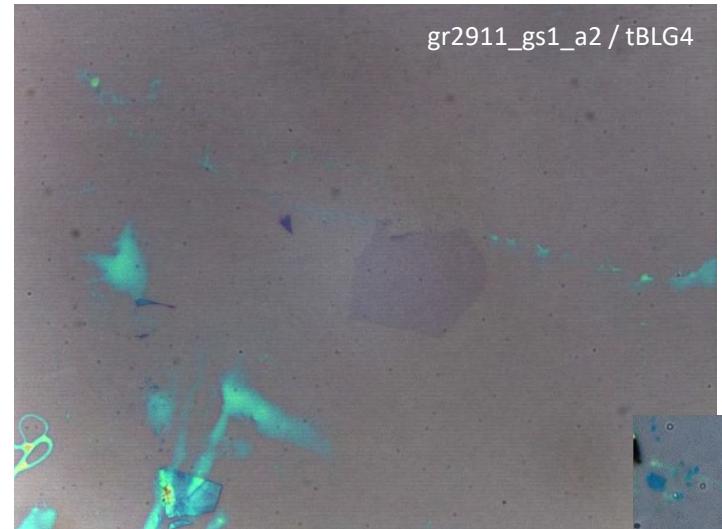
tBLG 2 before annealing - edge



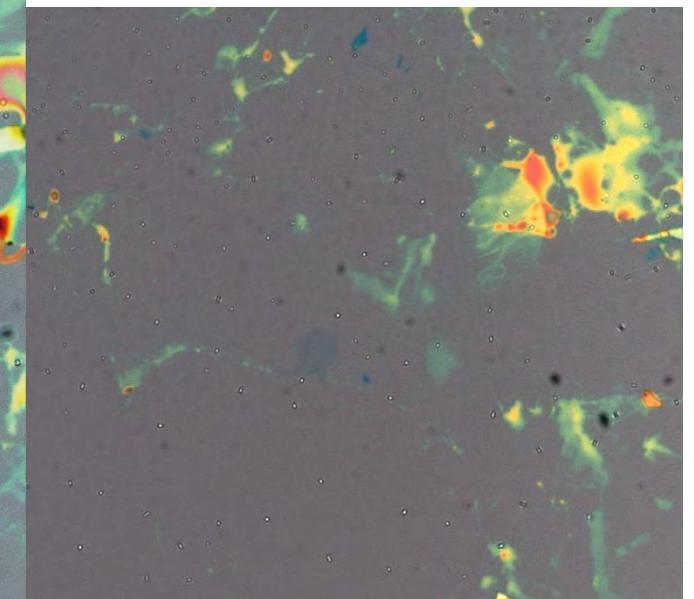
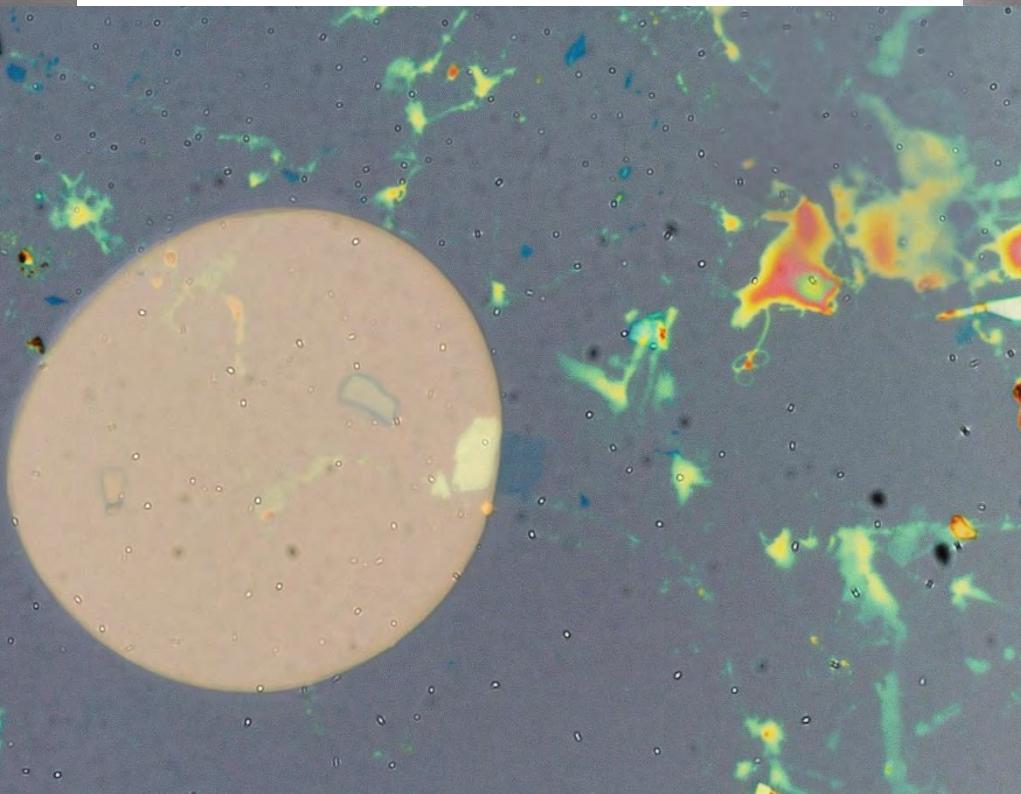
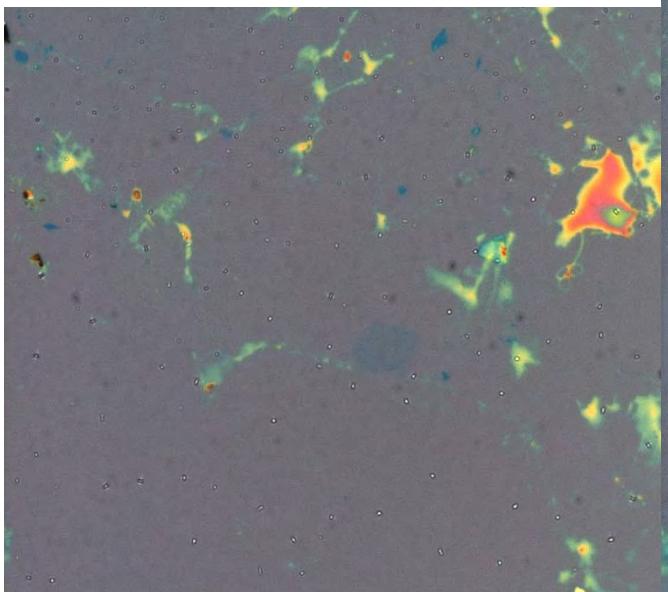
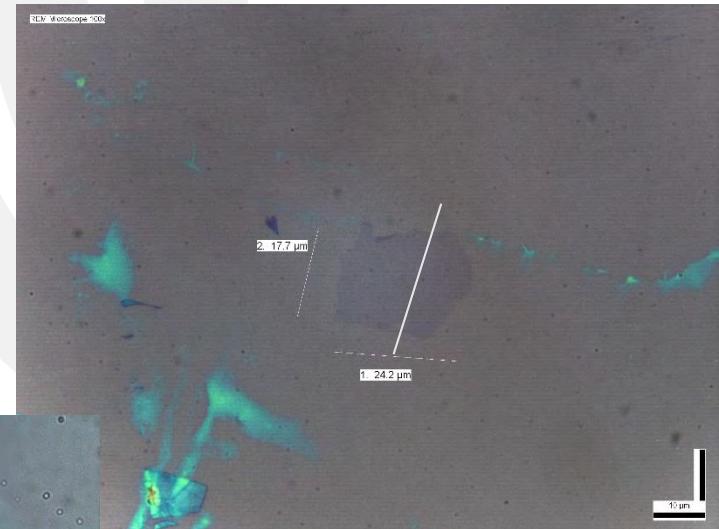
tBLG 3



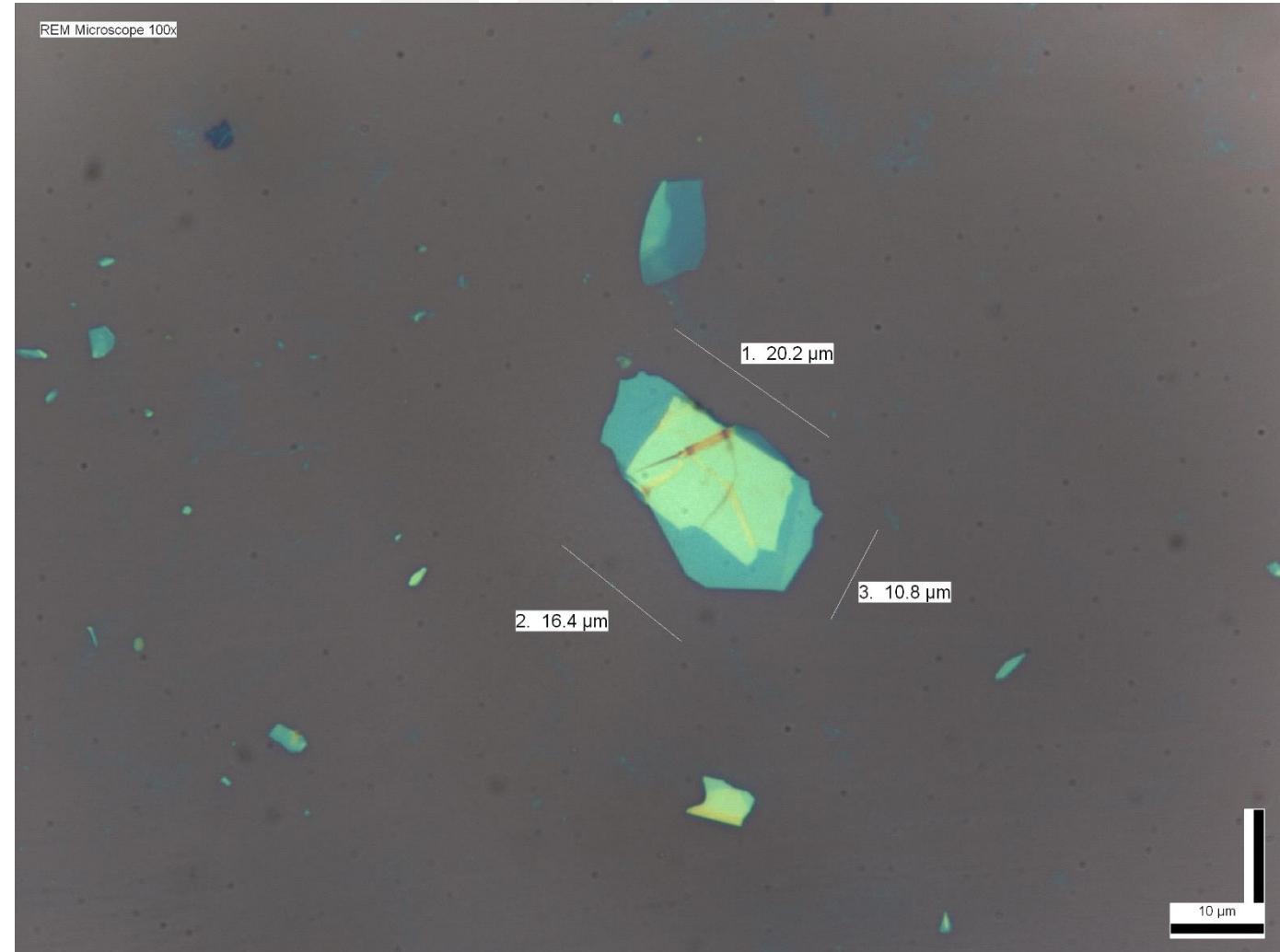
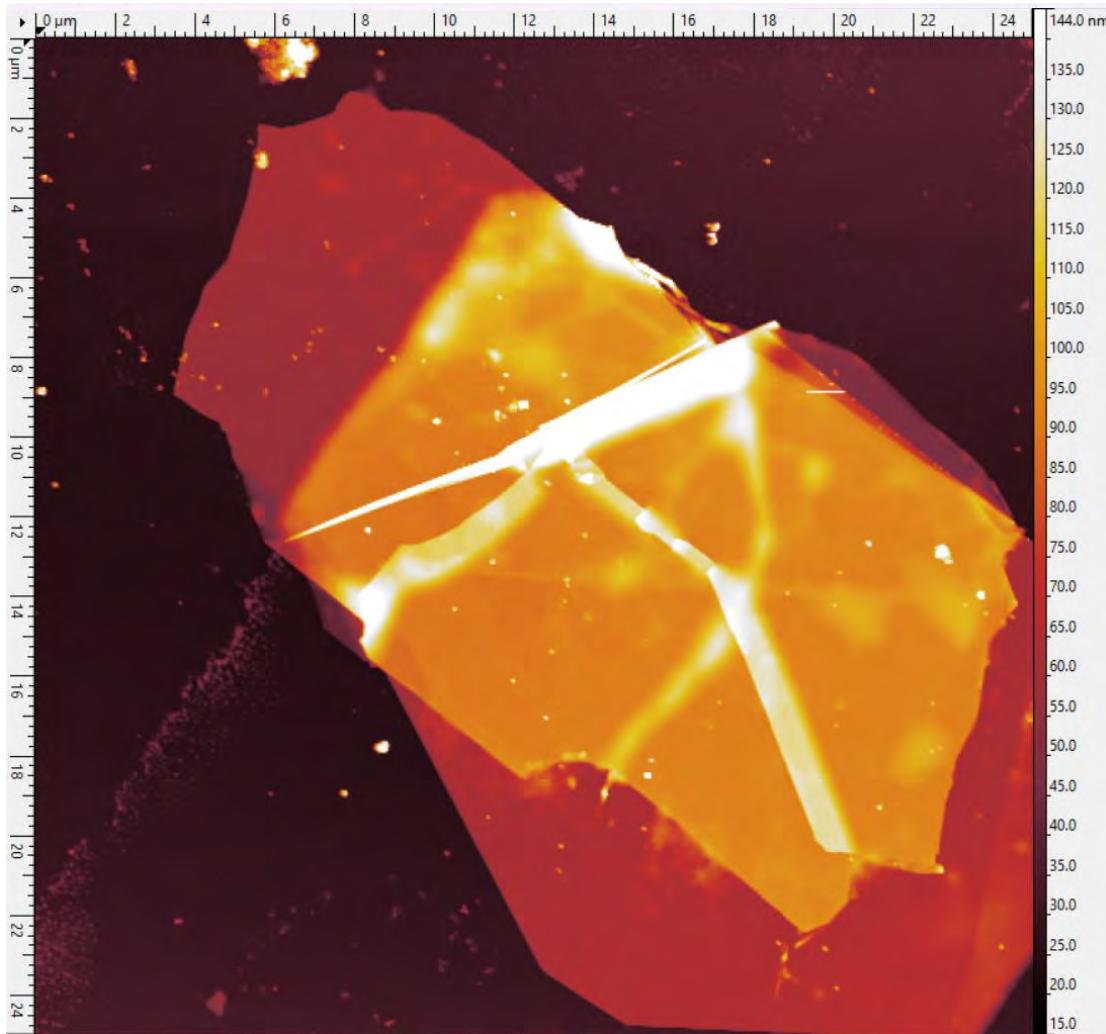
Clean Interface – tBLG4



AFM tear



Clean Interface – tBLG4



Clean Interface – tBLG4

